

## SN74AUP1G126 Low-Power Single Bus Buffer Gate With Tri-State Output

## 1 Features

- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22-
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Available in the Texas Instruments NanoStar™ Package
- Low Static-Power Consumption ( $I_{CC} = 0.9 \mu A$  Maximum)
- Low Dynamic-Power Consumption ( $C_{pd} = 4 \text{ pF}$  Typical at 3.3 V)
- Low Input Capacitance ( $C_i = 1.5 \text{ pF}$  Typical)
- Low Noise – Overshoot and Undershoot <10% of  $V_{CC}$
- Input-Disable Feature Allows Floating Input Conditions
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Input Hysteresis Allows Slow Input Transition and Better Switching Noise Immunity at Input
- Wide Operating  $V_{CC}$  Range of 0.8 V to 3.6 V
- Optimized for 3.3-V Operation
- 3.6-V I/O Tolerant to Support Mixed-Mode Signal Operation
- $t_{pd} = 4.6 \text{ ns}$  Maximum at 3.3 V
- Suitable for Point-to-Point Applications

## 2 Applications

- Audio Dock: Portable
- BluRay™ Players and Home Theaters
- Personal Digital Assistant (PDA)
- Power: Telecom/Server AC/DC Supply: Single Controller: Analog and Digital
- Solid-State Drive (SSD): Client and Enterprise
- TV: LCD/Digital and High-Definition (HDTV)
- Tablet: Enterprise
- Wireless Headsets, Keyboards, and Mice

### 3 Description

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family assures a very low static and dynamic power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see [AUP – The Lowest-Power Family](#) and [Excellent Signal Integrity](#) ).

This bus buffer gate is a single line driver with a 3-state output. The output is disabled when the output-enable (OE) input is low. This device has the input-disable feature, which allows floating input signals.

To assure the high-impedance state during power up or power down, OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

NanoStar™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.

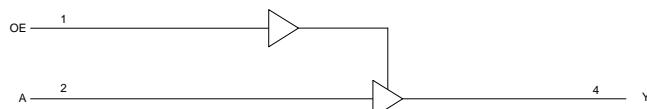
This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

## Device Information<sup>(1)</sup>

| PART NUMBER     | PACKAGE     | BODY SIZE (NOM)   |
|-----------------|-------------|-------------------|
| SN74AUP1G126DRL | SOT-5X3 (5) | 1.60 mm x 1.20 mm |
| SN74AUP1G126DBV | SOT-23 (5)  | 1.60 mm x 2.90 mm |
| SN74AUP1G126DCK | SC70 (5)    | 1.25 mm x 2.00 mm |
| SN74AUP1G126DRY | SON (6)     | 1.00 mm x 1.45 mm |
| SN74AUP1G126DSF | SON (6)     | 1.00 mm x 1.00 mm |
| SN74AUP1G126YFP | DSBGA (6)   | 0.76 mm x 1.16 mm |
| SN74AUP1G126YZP | DSBGA (5)   | 0.89 mm x 1.39 mm |
| SN74AUP1G126DPW | X2SON (5)   | 0.80 mm x 0.80 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Logic Diagram (Positive Logic)



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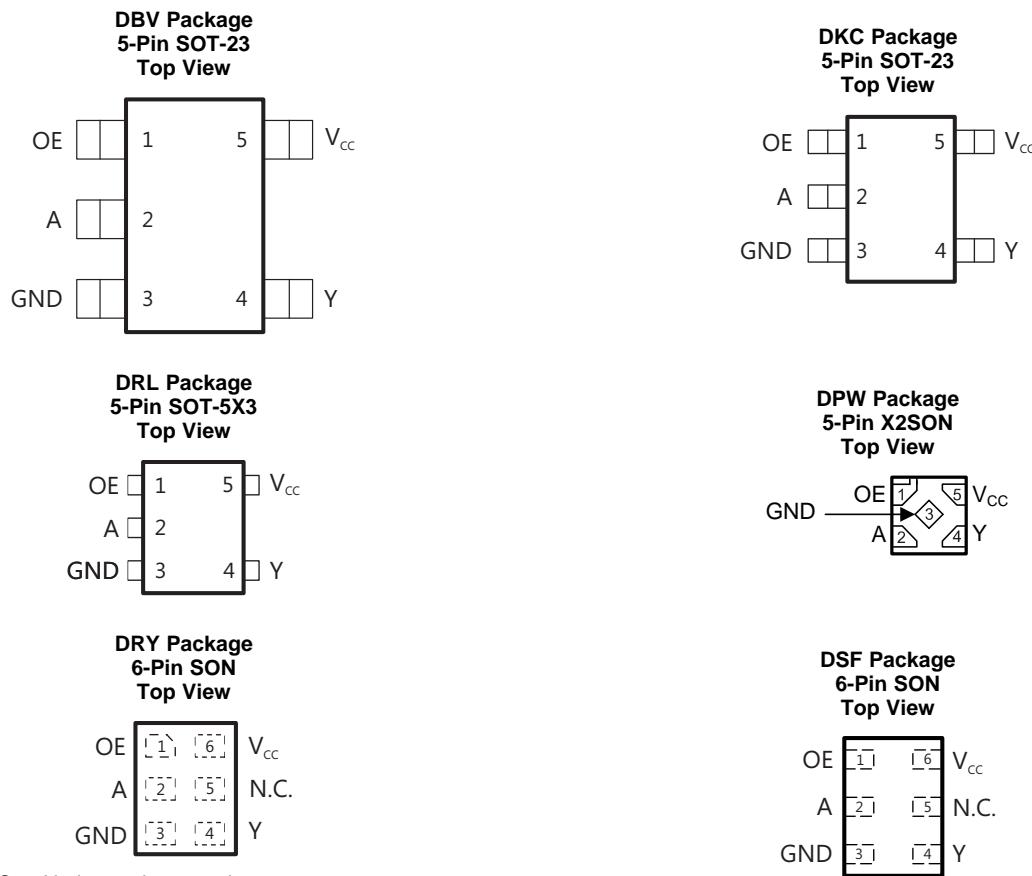
|          |                                                                   |           |           |                                                               |           |
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

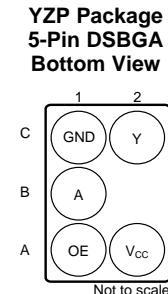
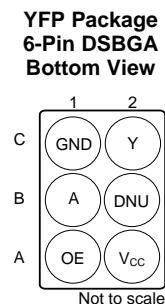
| Changes from Revision F (May 2010) to Revision G                                                                                                                                                                                                                                                                                                                                         | Page |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Added <i>Device Information</i> table, <i>Pin Configuration and Functions</i> section, <i>ESD Ratings</i> table, <i>Thermal Information</i> table, <i>Feature Description</i> section, <i>Application and Implementation</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section..... | 1    |
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## 5 Pin Configuration and Functions



N.C. – No internal connection.

See mechanical drawings for dimensions.



### Pin Functions

| NAME            | PIN                   |             |     |     | I/O | DESCRIPTION                 |
|-----------------|-----------------------|-------------|-----|-----|-----|-----------------------------|
|                 | DBV, DCK,<br>DRL, DPW | DRY,<br>DSF | YFP | YZP |     |                             |
| A               | 2                     | 2           | B1  | B1  | I   | Input                       |
| DNU             | —                     | —           | —   | B2  | —   | Do not use                  |
| GND             | 3                     | 3           | C1  | C1  | —   | Ground                      |
| N.C.            | —                     | 5           | B2  | —   | —   | No Internal Connection      |
| OE              | 1                     | 1           | A1  | A1  | I   | Output enable (active high) |
| V <sub>cc</sub> | 5                     | 6           | A2  | A2  | —   | Positive supply             |
| Y               | 4                     | 4           | C2  | C2  | O   | Buffered output             |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|           |                                                                                             | MIN       | MAX            | UNIT |
|-----------|---------------------------------------------------------------------------------------------|-----------|----------------|------|
| $V_{CC}$  | Supply voltage                                                                              | -0.5      | 4.6            | V    |
| $V_I$     | Input voltage <sup>(2)</sup>                                                                | -0.5      | 4.6            | V    |
| $V_O$     | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | -0.5      | 4.6            | V    |
| $V_O$     | Output voltage range in the high or low state <sup>(2)</sup>                                | -0.5      | $V_{CC} + 0.5$ | V    |
| $I_{IK}$  | Input clamp current                                                                         | $V_I < 0$ | -50            | mA   |
| $I_{OK}$  | Output clamp current                                                                        | $V_O < 0$ | -50            | mA   |
| $I_O$     | Continuous output current                                                                   |           | $\pm 20$       | mA   |
|           | Continuous current through $V_{CC}$ or GND                                                  |           | $\pm 50$       | mA   |
| $T_j$     | Junction Temperature                                                                        |           | 150            | °C   |
| $T_{stg}$ | Storage temperature                                                                         | -65       | 150            | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 6.2 ESD Ratings

|             |                         | VALUE                                                                          | UNIT |
|-------------|-------------------------|--------------------------------------------------------------------------------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | 2000 |
|             |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | 1000 |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

See<sup>(1)</sup>

|          |                           | MIN                        | MAX                  | UNIT                 |
|----------|---------------------------|----------------------------|----------------------|----------------------|
| $V_{CC}$ | Supply voltage            | 0.8                        | 3.6                  | V                    |
| $V_{IH}$ | High-level input voltage  | $V_{CC} = 0.8$ V           | $V_{CC}$             | 3.6                  |
|          |                           | $V_{CC} = 1.1$ V to 1.95 V | $0.65 \times V_{CC}$ | 3.6                  |
|          |                           | $V_{CC} = 2.3$ V to 2.7 V  | 1.6                  | 3.6                  |
|          |                           | $V_{CC} = 3$ V to 3.6 V    | 2                    | 3.6                  |
| $V_{IL}$ | Low-level input voltage   | $V_{CC} = 0.8$ V           | 0                    |                      |
|          |                           | $V_{CC} = 1.1$ V to 1.95 V | 0                    | $0.35 \times V_{CC}$ |
|          |                           | $V_{CC} = 2.3$ V to 2.7 V  | 0                    | 0.7                  |
|          |                           | $V_{CC} = 3$ V to 3.6 V    | 0                    | 0.9                  |
| $V_O$    | Output voltage            | Active state               | 0                    | $V_{CC}$             |
|          |                           | 3-state                    | 0                    | 3.6                  |
| $I_{OH}$ | High-level output current | $V_{CC} = 0.8$ V           | -20                  | $\mu A$              |
|          |                           | $V_{CC} = 1.1$ V           | -1.1                 |                      |
|          |                           | $V_{CC} = 1.4$ V           | -1.7                 |                      |
|          |                           | $V_{CC} = 1.65$ V          | -1.9                 |                      |
|          |                           | $V_{CC} = 2.3$ V           | -3.1                 |                      |
|          |                           | $V_{CC} = 3$ V             | -4                   |                      |

(1) All unused inputs of the device must be held at  $V_{CC}$  or GND to assure proper device operation. See *Implications of Slow or Floating CMOS Inputs*.

## Recommended Operating Conditions (continued)

See<sup>(1)</sup>

|                     |                                    |                           | MIN | MAX | UNIT    |
|---------------------|------------------------------------|---------------------------|-----|-----|---------|
| $I_{OL}$            | Low-level output current           | $V_{CC} = 0.8$ V          |     | 20  | $\mu$ A |
|                     |                                    | $V_{CC} = 1.1$ V          |     | 1.1 | mA      |
|                     |                                    | $V_{CC} = 1.4$ V          |     | 1.7 |         |
|                     |                                    | $V_{CC} = 1.65$ V         |     | 1.9 |         |
|                     |                                    | $V_{CC} = 2.3$ V          |     | 3.1 |         |
|                     |                                    | $V_{CC} = 3$ V            |     | 4   |         |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 0.8$ V to 3.6 V |     | 200 | ns/V    |
| $T_A$               | Operating free-air temperature     |                           | -40 | 85  | °C      |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> | SN74AUP1G126                                 |                 |               |              |              |                |                |                | UNIT  |      |
|-------------------------------|----------------------------------------------|-----------------|---------------|--------------|--------------|----------------|----------------|----------------|-------|------|
|                               | DRL<br>(SOT-5X3)                             | DBV<br>(SOT-23) | DCK<br>(SC70) | DRY<br>(SON) | DSF<br>(SON) | DPW<br>(X2SON) | YFP<br>(DSBGA) | YZP<br>(DSBGA) |       |      |
|                               | 5 PINS                                       | 5 PINS          | 5 PINS        | 6 PINS       | 6 PINS       | 5 PINS         | 6 PINS         | 5 PINS         |       |      |
| $R_{iJA}$                     | Junction-to-ambient thermal resistance       | 295.1           | 230.5         | 303.6        | 342.1        | 377.1          | 504.3          | 125.4          | 146.2 | °C/W |
| $R_{iJC(top)}$                | Junction-to-case (top) thermal resistance    | 131.0           | 172.7         | 203.8        | 233.1        | 187.7          | 234.9          | 1.9            | 1.4   | °C/W |
| $R_{iJB}$                     | Junction-to-board thermal resistance         | 143.9           | 62.2          | 100.9        | 206.7        | 236.6          | 370.3          | 37.2           | 39.3  | °C/W |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 14.7            | 49.3          | 76.1         | 63.4         | 29.0           | 44.5           | 0.5            | 0.7   | °C/W |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 144.4           | 61.6          | 99.3         | 206.7        | 236.3          | 369.7          | 37.5           | 39.8  | °C/W |
| $R_{iJC(bot)}$                | Junction-to-case (bottom) thermal resistance | N/A             | N/A           | N/A          | N/A          | N/A            | 165.2          | N/A            | N/A   | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS        | $V_{CC}$                             | MIN            | TYP                  | MAX | UNIT |  |
|-----------|------------------------|--------------------------------------|----------------|----------------------|-----|------|--|
| $V_{OH}$  | $I_{OH} = -20$ $\mu$ A | $T_A = 25^\circ C$                   | 0.8 V to 3.6 V | $V_{CC} - 0.1$       |     | V    |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | $V_{CC} - 0.1$       |     |      |  |
|           | $I_{OH} = -1.1$ mA     | $T_A = 25^\circ C$                   | 1.1 V          | 0.75 $\times V_{CC}$ |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 0.7 $\times V_{CC}$  |     |      |  |
|           | $I_{OH} = -1.7$ mA     | $T_A = 25^\circ C$                   | 1.4 V          | 1.11                 |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 1.03                 |     |      |  |
|           | $I_{OH} = -1.9$ mA     | $T_A = 25^\circ C$                   | 1.65 V         | 1.32                 |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 1.3                  |     |      |  |
|           | $I_{OH} = -2.3$ mA     | $T_A = 25^\circ C$                   | 2.3 V          | 2.05                 |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 1.97                 |     |      |  |
|           | $I_{OH} = -3.1$ mA     | $T_A = 25^\circ C$                   | 3 V            | 1.9                  |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 1.85                 |     |      |  |
|           | $I_{OH} = -2.7$ mA     | $T_A = 25^\circ C$                   | 3 V            | 2.72                 |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 2.67                 |     |      |  |
|           | $I_{OH} = -4$ mA       | $T_A = 25^\circ C$                   | 3 V            | 2.6                  |     |      |  |
|           |                        | $T_A = -40^\circ C$ to $+85^\circ C$ |                | 2.55                 |     |      |  |

## Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         | TEST CONDITIONS                                                                                                               |                                 | V <sub>CC</sub> | MIN | TYP | MAX                   | UNIT |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------|---------------------------------|-----------------|-----|-----|-----------------------|------|
| V <sub>OL</sub>   | I <sub>OL</sub> = 20 µA                                                                                                       | T <sub>A</sub> = 25°C           | 0.8 V to 3.6 V  |     |     | 0.1                   | V    |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.1                   |      |
|                   | I <sub>OL</sub> = 1.1 mA                                                                                                      | T <sub>A</sub> = 25°C           | 1.1 V           |     |     | 0.3 × V <sub>CC</sub> |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.3 × V <sub>CC</sub> |      |
|                   | I <sub>OL</sub> = 1.7 mA                                                                                                      | T <sub>A</sub> = 25°C           | 1.4 V           |     |     | 0.31                  |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.37                  |      |
|                   | I <sub>OL</sub> = 1.9 mA                                                                                                      | T <sub>A</sub> = 25°C           | 1.65 V          |     |     | 0.31                  |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.35                  |      |
|                   | I <sub>OL</sub> = 2.3 mA                                                                                                      | T <sub>A</sub> = 25°C           | 2.3 V           |     |     | 0.31                  |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.33                  |      |
|                   | I <sub>OL</sub> = 3.1 mA                                                                                                      | T <sub>A</sub> = 25°C           | 3 V             |     |     | 0.44                  |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.45                  |      |
| I <sub>I</sub>    | A or OE input                                                                                                                 | T <sub>A</sub> = 25°C           | 0 V to 3.6 V    |     |     | 0.1                   | µA   |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.5                   |      |
|                   | I <sub>off</sub>                                                                                                              | T <sub>A</sub> = 25°C           | 0 V             |     |     | 0.2                   |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.6                   |      |
| ΔI <sub>off</sub> | V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V                                                                               | T <sub>A</sub> = 25°C           | 0 V to 0.2 V    |     |     | 0.2                   | µA   |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.6                   |      |
| I <sub>OZ</sub>   | V <sub>O</sub> = V <sub>CC</sub> or GND, T <sub>A</sub> = -40°C to +85°C                                                      |                                 | 3.6 V           |     |     | 0.5                   | µA   |
| I <sub>CC</sub>   | V <sub>I</sub> = GND or (V <sub>CC</sub> to 3.6 V), OE = GND, I <sub>O</sub> = 0                                              | T <sub>A</sub> = 25°C           | 0.8 V to 3.6 V  |     |     | 0.5                   | µA   |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 0.9                   |      |
| ΔI <sub>CC</sub>  | A input<br>OE input                                                                                                           | T <sub>A</sub> = 25°C           | 3.3 V           |     |     | 40                    | µA   |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 50                    |      |
|                   |                                                                                                                               | T <sub>A</sub> = 25°C           |                 |     |     | 110                   |      |
|                   |                                                                                                                               | T <sub>A</sub> = -40°C to +85°C |                 |     |     | 120                   |      |
| All inputs        | V <sub>I</sub> = GND to 3.6 V, OE = V <sub>CC</sub> <sup>(2)</sup> , T <sub>A</sub> = 25°C or T <sub>A</sub> = -40°C to +85°C |                                 | 0.8 V to 3.6 V  |     |     | 0                     |      |
| C <sub>i</sub>    | V <sub>I</sub> = V <sub>CC</sub> or GND, T <sub>A</sub> = 25°C                                                                |                                 | 0 V             |     |     | 1.5                   | pF   |
|                   |                                                                                                                               |                                 | 3.6 V           |     |     | 1.5                   |      |
| C <sub>o</sub>    | V <sub>O</sub> = V <sub>CC</sub> or GND, T <sub>A</sub> = 25°C                                                                |                                 | 3.6 V           |     |     | 3                     | pF   |

(1) One input at V<sub>CC</sub> – 0.6 V, other input at V<sub>CC</sub> or GND

(2) To show I<sub>CC</sub> is very low when the input-disable feature is enabled

## 6.6 Switching Characteristics: $C_L = 5 \text{ pF}$

over recommended operating free-air temperature range,  $C_L = 5 \text{ pF}$  (unless otherwise noted) (see [Figure 2](#) and [Figure 3](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                             |                                                         |  | MIN  | TYP | MAX  | UNIT |
|-----------|-----------------|----------------|---------------------------------------------|---------------------------------------------------------|--|------|-----|------|------|
| $t_{pd}$  | A               | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 18.1 |     |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 4.3  | 7.4 | 12.6 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.7  |     | 15.3 |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.3  | 5.2 | 8.5  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1    |     | 10.2 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 2.6  | 4.1 | 6.8  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.3  |     | 8.3  |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2    | 2.9 | 4.7  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.1  |     | 5.8  |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 1.7  | 2.4 | 3.8  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1    |     | 4.6  |      |
| $t_{en}$  | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 19.1 |     |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 5.1  | 9.3 | 15.9 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.6  |     | 19.2 |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 4.1  | 6.6 | 10.5 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.5  |     | 12.7 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 3.2  | 5.3 | 8.7  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.1  |     | 10.3 |      |
| $t_{dis}$ | OE              | Y              | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.5  | 3.8 | 6    | ns   |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.6  |     | 7.2  |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.1  | 3.2 | 4.9  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.4  |     | 5.9  |      |
|           |                 |                | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 12.1 |     |      |      |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.4  | 4.1 | 6.9  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.2  |     | 7.7  |      |

## 6.7 Switching Characteristics: $C_L = 10 \text{ pF}$

over recommended operating free-air temperature range,  $C_L = 10 \text{ pF}$  (unless otherwise noted) (see [Figure 2](#) and [Figure 3](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                             |                                                         |  | MIN  | TYP  | MAX  | UNIT |
|-----------|-----------------|----------------|---------------------------------------------|---------------------------------------------------------|--|------|------|------|------|
| $t_{pd}$  | A or B          | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 20.5 | 13.7 |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 4.6  | 8.4  | 9.3  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.6  |      | 16.6 |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.5  | 5.9  | 7.5  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.4  |      | 11.1 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 3.9  | 4.7  | 5.3  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.3  |      | 9.1  |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.3  | 3.4  | 4.3  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.6  |      | 6.4  |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.1  |      | 2.8  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.4  |      | 5.2  |      |
| $t_{en}$  | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 21.8 | 16.8 |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 4.9  | 10.2 | 11.2 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 4.4  |      | 20.2 |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.9  | 7.3  | 9.2  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.3  |      | 13.5 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 3.4  | 5.8  | 6.4  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.7  |      | 11   |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.5  | 4.3  | 5.4  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.1  |      | 7.8  |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.1  |      | 3.7  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.9  |      | 6.4  |      |
| $t_{dis}$ | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 13   |      |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.8  | 6.6  | 11.7 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.2  |      | 14   |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 2.2  | 4.7  | 7.9  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.3  |      | 9.3  |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 2.4  | 4.4  | 6.4  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 2.2  |      | 7.5  |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 1.3  | 3.1  | 4.9  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.2  |      | 5.4  |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 1.9  | 3.4  | 5    |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1.9  |      | 5.6  |      |

## 6.8 Switching Characteristics: $C_L = 15 \text{ pF}$

over recommended operating free-air temperature range,  $C_L = 15 \text{ pF}$  (unless otherwise noted) (see [Figure 2](#) and [Figure 3](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                                         |  |                          | MIN  | TYP  | MAX  | UNIT |  |
|-----------|-----------------|----------------|---------------------------------------------------------|--|--------------------------|------|------|------|------|--|
| $t_{pd}$  | A or B          | Y              | $V_{CC} = 0.8 \text{ V}$                                |  | $T_A = 25^\circ\text{C}$ |      |      | 22.5 |      |  |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 5.8  | 9.3  | 15.1 | ns   |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 4.3  | 17.9 |      |      |  |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 4.4  | 6.6  | 10.2 |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 3    | 12.1 |      |      |  |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$             |  | $T_A = 25^\circ\text{C}$ | 3.5  | 5.3  | 8.3  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 2.3  | 9.9  |      |      |  |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 2.7  | 3.9  | 5.8  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 1.9  | 7    |      |      |  |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 2.4  | 3.2  | 4.7  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 1.8  | 5.7  |      |      |  |
| $t_{en}$  | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                                |  | $T_A = 25^\circ\text{C}$ | 25.2 |      | ns   | ns   |  |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 7    | 11.3 | 18.1 |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 5.4  | 21.4 |      |      |  |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 5.5  | 8.1  | 12.2 |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 4.1  | 14.5 |      |      |  |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$             |  | $T_A = 25^\circ\text{C}$ | 4.3  | 6.5  | 10.1 |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 3.3  | 12   |      |      |  |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 3.4  | 4.8  | 7.1  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 2.6  | 8.4  |      |      |  |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 2.9  | 4.1  | 5.9  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 2.3  | 6.9  |      |      |  |
| $t_{dis}$ | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                                |  | $T_A = 25^\circ\text{C}$ | 14   |      | ns   | ns   |  |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 3.7  | 5.8  | 8.2  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 3.3  | 11   |      |      |  |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 5.5  | 3.9  | 5.9  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 2.1  | 8    |      |      |  |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$             |  | $T_A = 25^\circ\text{C}$ | 3.3  | 4.5  | 6.6  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 2.9  | 7.4  |      |      |  |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 2.3  | 3.2  | 4.3  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 1.8  | 5.1  |      |      |  |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$              |  | $T_A = 25^\circ\text{C}$ | 2.4  | 4.8  | 6.2  |      |  |
|           |                 |                | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | $T_A = 25^\circ\text{C}$ | 3.1  | 6.7  |      |      |  |

## 6.9 Switching Characteristics: $C_L = 30 \text{ pF}$

over recommended operating free-air temperature range,  $C_L = 30 \text{ pF}$  (unless otherwise noted) (see [Figure 2](#) and [Figure 3](#))

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                             |                                                         |  | MIN  | TYP  | MAX  | UNIT |
|-----------|-----------------|----------------|---------------------------------------------|---------------------------------------------------------|--|------|------|------|------|
| $t_{pd}$  | A or B          | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 29   |      |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 7.4  | 12   | 18.7 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 6.6  |      | 21.4 |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 5.7  | 8.6  | 12.5 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 4.9  |      | 14.7 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 4.8  | 6.9  | 10.1 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.1  |      | 12   |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.9  | 5.1  | 7.2  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.3  |      | 8.7  |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.5  | 4.8  | 6    |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3    |      | 7    |      |
| $t_{en}$  | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 33.4 |      |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 8.8  | 14.1 | 21.8 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 7.4  |      | 25.5 |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 6.9  | 10.1 | 14.6 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 5.6  |      | 17.4 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 5.6  | 8.1  | 12   |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 4.7  |      | 14.1 |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 4.3  | 6.1  | 8.5  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.8  |      | 10   |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.7  | 5.2  | 7.1  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.4  |      | 8.3  |      |
| $t_{dis}$ | OE              | Y              | $V_{CC} = 0.8 \text{ V}$                    | $T_A = 25^\circ\text{C}$                                |  | 17.7 |      |      | ns   |
|           |                 |                | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 5.8  | 10   | 16   |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.7  |      | 16   |      |
|           |                 |                | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 5.7  | 7.7  | 10.9 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 1    |      | 10.7 |      |
|           |                 |                | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $T_A = 25^\circ\text{C}$                                |  | 4.5  | 7.7  | 9.8  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 4.4  |      | 12.5 |      |
|           |                 |                | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.9  | 5.6  | 7.4  |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 3.2  |      | 9    |      |
|           |                 |                | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  | $T_A = 25^\circ\text{C}$                                |  | 3.3  | 8.4  | 10.7 |      |
|           |                 |                |                                             | $T_A = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ |  | 6.6  |      | 10.8 |      |

## 6.10 Operating Characteristics

 $T_A = 25^\circ\text{C}$ 

| PARAMETER       |                               | TEST CONDITIONS               | V <sub>CC</sub> | TYP | UNIT |
|-----------------|-------------------------------|-------------------------------|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance | Output enabled<br>f = 10 MHz  | 0.8 V           | 3.8 | pF   |
|                 |                               |                               | 1.2 V ± 0.1 V   | 3.7 |      |
|                 |                               |                               | 1.5 V ± 0.1 V   | 3.7 |      |
|                 |                               |                               | 1.8 V ± 0.15 V  | 3.7 |      |
|                 |                               |                               | 2.5 V ± 0.2 V   | 3.9 |      |
|                 |                               |                               | 3.3 V ± 0.3 V   | 4   |      |
|                 | Power dissipation capacitance | Output disabled<br>f = 10 MHz | 0.8 V           | 0   |      |
|                 |                               |                               | 1.2 V ± 0.1 V   | 0   |      |
|                 |                               |                               | 1.5 V ± 0.1 V   | 0   |      |
|                 |                               |                               | 1.8 V ± 0.15 V  | 0   |      |
|                 |                               |                               | 2.5 V ± 0.2 V   | 0   |      |
|                 |                               |                               | 3.3 V ± 0.3 V   | 0   |      |

## 6.11 Typical Characteristics

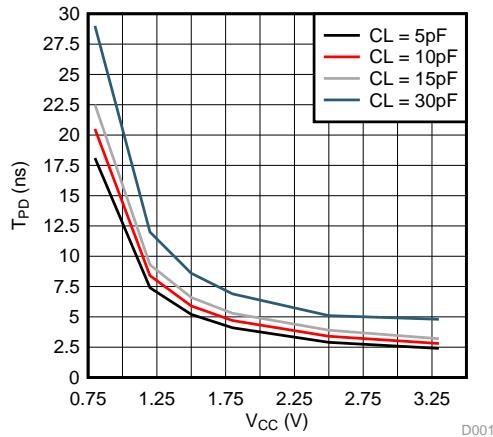
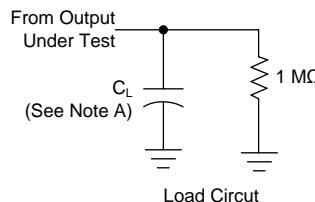


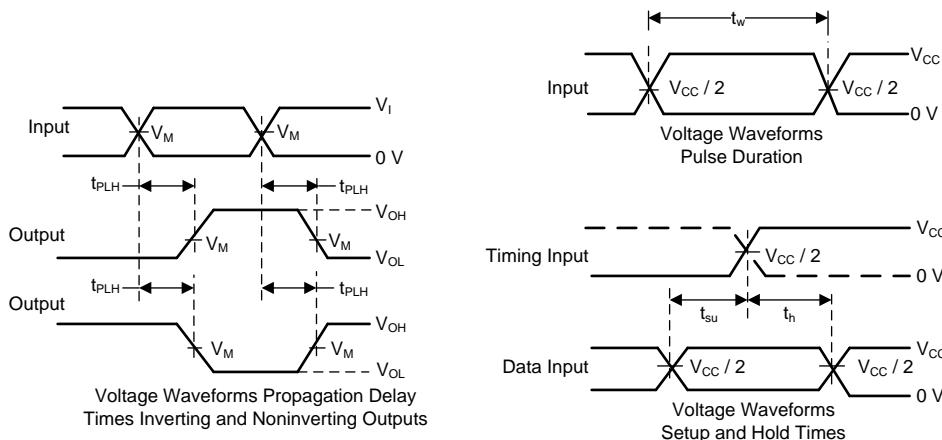
Figure 1. Propagation Delay vs. Supply Voltage and Load Capacitance

## 7 Parameter Measurement Information

### 7.1 (Propagation Delays, Setup and Hold Times, and Pulse Width)



|       | $V_{CC} = 0.8 \text{ V}$       | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$ | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$ | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ |
|-------|--------------------------------|--------------------------------------------|--------------------------------------------|---------------------------------------------|--------------------------------------------|--------------------------------------------|
| $C_L$ | 5, 10, 15, 30 pF<br>$V_{CC}/2$ | 5, 10, 15, 30 pF<br>$V_{CC}/2$             | 5, 10, 15, 30 pF<br>$V_{CC}/2$             | 5, 10, 15, 30 pF<br>$V_{CC}/2$              | 5, 10, 15, 30 pF<br>$V_{CC}/2$             | 5, 10, 15, 30 pF<br>$V_{CC}/2$             |

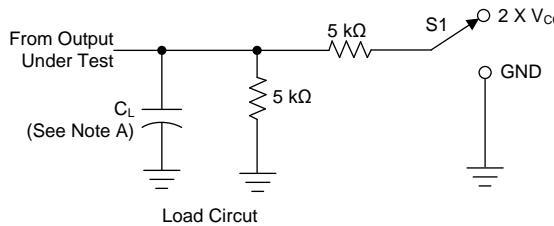


Notes:

- A.  $C_L$  includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r / t_f = 3 \text{ ns}$ .
- C. The outputs are measured one at a time, with one transition per measurement.
- D.  $t_{PLH}$  And  $t_{PHL}$  Are the same as  $T_{pd}$ .
- E. All parameters and waveforms are not applicable in all devices.

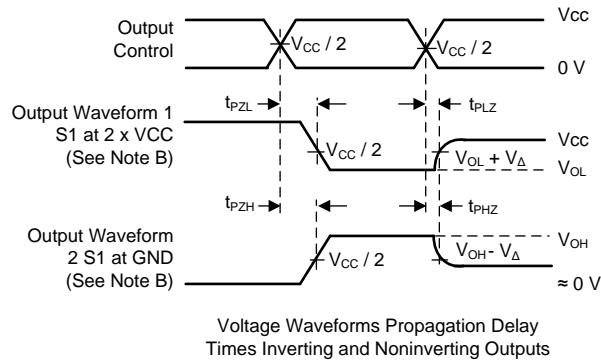
Figure 2. Load Circuit and Voltage Waveforms

## 7.2 (Enable and Disable Times)



| Test                                       | S1             |
|--------------------------------------------|----------------|
| $t_{PLZ} / t_{PZL}$<br>$t_{PHZ} / t_{PZH}$ | 2 x Vcc<br>GND |

|                                       | $V_{CC} = 0.8 \text{ V}$                     | $V_{CC} = 1.2 \text{ V} \pm 0.1 \text{ V}$   | $V_{CC} = 1.5 \text{ V} \pm 0.1 \text{ V}$   | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$  | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$   | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$   |
|---------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|
| $C_L$<br>$V_M$<br>$V_I$<br>$V_\Delta$ | 5, 10, 15, 30 pF<br>$V_{CC} / 2$<br>$V_{CC}$ |



Voltage Waveforms Propagation Delay  
Times Inverting and Noninverting Outputs

Notes:

- A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_0 = 50 \Omega$ ,  $t_r / t_f = 3 \text{ ns}$
- D. The outputs are measured one at a time, with one transmission per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G. All parameters and waveforms are not applicable to all devices.

**Figure 3. Load Circuit and Voltage Waveforms**

## 8 Detailed Description

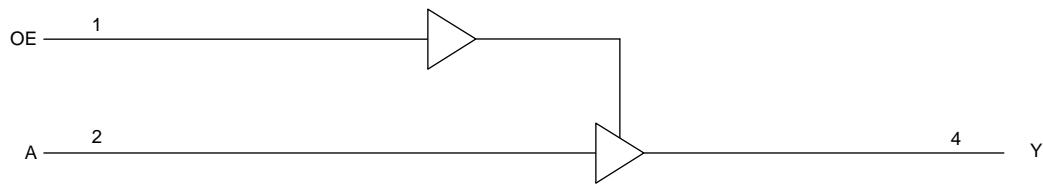
### 8.1 Overview

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family of devices is specified for low static and dynamic power consumption across the entire  $V_{CC}$  range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see [Figure 7](#) and [Figure 8](#)).

The SN74AUP1G126 device contains one buffer gate device with output enable control and performs the Boolean function  $Y = A$ . This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs when the device is powered down. This inhibits current backflow into the device which prevents damage to the device.

To assure the high-impedance state during power up or power down, OE must be tied to GND through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

### 8.2 Functional Block Diagram



**Figure 4. Logic Diagram (Positive Logic)**

### 8.3 Feature Description

#### 8.3.1 Balanced CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The drive capability of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important for the power output of the device to be limited to avoid thermal runaway and damage due to over-current. The electrical and thermal limits defined in the [Absolute Maximum Ratings](#) must be followed at all times.

#### 8.3.2 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modelled as a resistor in parallel with the input capacitance given in the [Electrical Characteristics](#). The worst case resistance is calculated with the maximum input voltage, given in the [Absolute Maximum Ratings](#), and the maximum input leakage current, given in the [Electrical Characteristics](#), using ohm's law ( $R = V \div I$ ).

Signals applied to the inputs must have fast edge rates, as defined by  $\Delta t/\Delta v$  in [Recommended Operating Conditions](#) to avoid excessive currents and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be used to condition the input signal prior to the standard CMOS input.

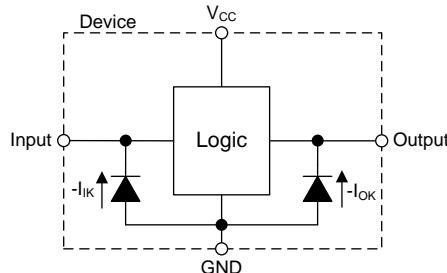
## Feature Description (continued)

### 8.3.3 Clamp Diodes

The inputs and outputs to this device have negative clamping diodes.

#### CAUTION

Voltages beyond the values specified in the *Absolute Maximum Ratings* table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



**Figure 5. Electrical Placement of Clamping Diodes for Each Input and Output**

### 8.3.4 Partial Power Down ( $I_{off}$ )

The inputs and outputs for this device enter a high-impedance state when the supply voltage is 0 V. The maximum leakage into or out of any input or output pin on the device is specified by  $I_{off}$  in the *Electrical Characteristics*.

### 8.3.5 Overvoltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the *Absolute Maximum Ratings*.

### 8.3.6 Output Enable

This device has an output enable (OE) pin that functions according to [Table 1](#). When the outputs of the device are disabled, they are placed into a high impedance state where it will neither source nor sink current. High-impedance outputs are also commonly referred to as three-state or tri-state outputs. The maximum leakage for the output in this state is defined by  $I_{OZ}$  in the *Electrical Characteristics* table.

## 8.4 Device Functional Modes

[Table 1](#) lists the functional modes of the SN74AUP1G126 device.

**Table 1. Function Table**

| INPUTS |   | OUTPUT<br>Y |
|--------|---|-------------|
| OE     | A |             |
| H      | H | H           |
| H      | L | L           |
| L      | X | Z           |

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The SN74AUP1G126 device is an output enabled CMOS buffer that can be used in LED indicator applications that require less than 4 mA. The device can produce up to 4 mA of drive current at 3.3 V. The inputs to the device are also overvoltage tolerant up to 3.6 V, allowing it to translate down to any valid  $V_{CC}$ .

### 9.2 Typical Application

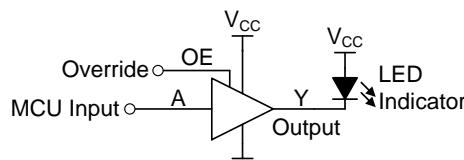


Figure 6. Application Schematic with MCU driving an LED Indicator

#### 9.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The output drive strength of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing.

#### 9.2.2 Detailed Design Procedure

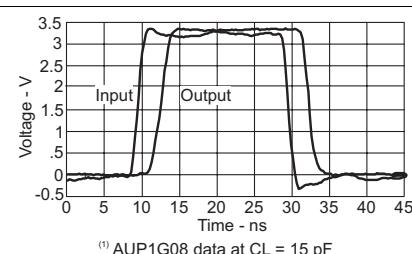
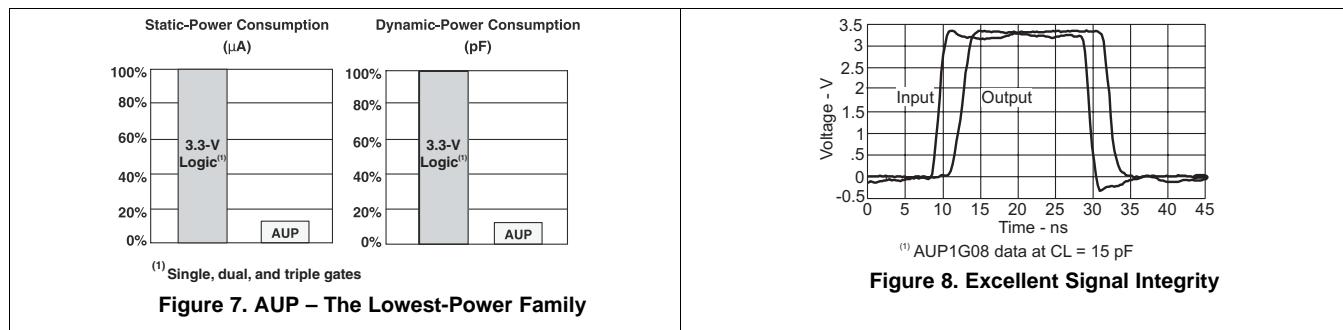
##### 1. Recommended Input Conditions

- Rise time and fall time specs. See ( $\Delta t/\Delta V$ ) in the *Recommended Operating Conditions* table.
- Specified high and low levels. See ( $V_{IH}$  and  $V_{IL}$ ) in the *Recommended Operating Conditions* table.
- Inputs are overvoltage tolerant allowing them to go as high as ( $V_I$  max) in the *Recommended Operating Conditions* table at any valid  $V_{CC}$ .

##### 2. Recommended Output Conditions

- Load currents should not exceed ( $I_O$  max) per output and should not exceed (Continuous current through  $V_{CC}$  or GND) total current for the part. These limits are located in the *Absolute Maximum Ratings* table.
- Outputs should not be pulled above  $V_{CC}$ .

#### 9.2.3 Application Curves



## 10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions* table.

The VCC pin must have a good bypass capacitor to prevent power disturbance. TI recommends to use a  $0.1\text{-}\mu\text{F}$  capacitor for this device. It is ok to parallel multiple bypass caps to reject different frequencies of noise.  $0.1\text{-}\mu\text{F}$  and  $1\text{-}\mu\text{F}$  capacitors are commonly used in parallel. Install the bypass capacitor as close to the power pin as possible for best results.

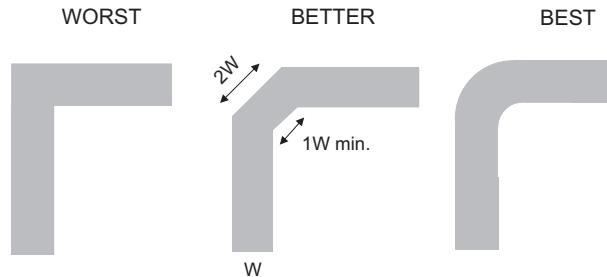
## 11 Layout

### 11.1 Layout Guidelines

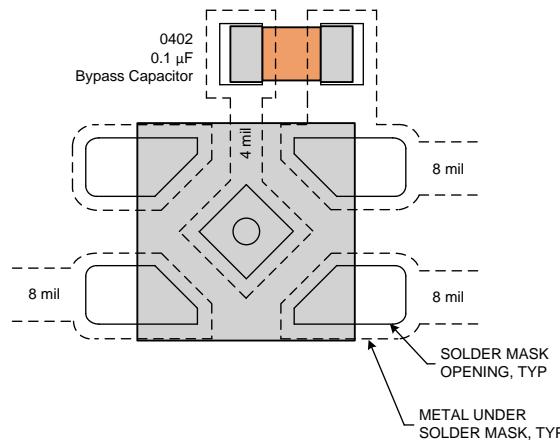
Even low data rate digital signals can contain high-frequency signal components due to fast edge rates. When a printed-circuit board (PCB) trace turns a corner at a  $90^\circ$  angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self-inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

An example layout is given in for the DPW (X2SON-5) package. This example layout includes a 0402 (metric) capacitor and uses the measurements found in the example board layout appended to this end of this datasheet. A via of diameter 0.1 mm (3.973 mil) is placed directly in the center of the device. This via can be used to trace out the center pin connection through another board layer, or it can be left out of the layout.

### 11.2 Layout Example



**Figure 9. Trace Example**



**Figure 10. Example Layout With DPW (X2SON-5) Package**

## 12 Device and Documentation Support

### 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

*Implications of Slow of Floating CMOS Inputs* application report

### 12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.4 Trademarks

NanoStar, E2E are trademarks of Texas Instruments.

BluRay is a trademark of Blu-ray Disc Association (BDA).

All other trademarks are the property of their respective owners.

### 12.5 Electrostatic Discharge Caution

 This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

 ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 12.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable part number                | Status<br>(1) | Material type<br>(2) | Package   Pins    | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)  |
|--------------------------------------|---------------|----------------------|-------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|----------------------|
| <a href="#">SN74AUP1G126DBVR</a>     | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | H26R                 |
| <a href="#">SN74AUP1G126DBVR.B</a>   | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | H26R                 |
| <a href="#">SN74AUP1G126DBVRG4</a>   | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | H26R                 |
| <a href="#">SN74AUP1G126DBVRG4.B</a> | Active        | Production           | SOT-23 (DBV)   5  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | H26R                 |
| <a href="#">SN74AUP1G126DBVT</a>     | Active        | Production           | SOT-23 (DBV)   5  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | H26R                 |
| <a href="#">SN74AUP1G126DBVT.B</a>   | Active        | Production           | SOT-23 (DBV)   5  | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | H26R                 |
| <a href="#">SN74AUP1G126DCKR</a>     | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 85    | (HN5, HNF, HNK, HNR) |
| <a href="#">SN74AUP1G126DCKR.B</a>   | Active        | Production           | SC70 (DCK)   5    | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | (HN5, HNF, HNK, HNR) |
| <a href="#">SN74AUP1G126DCKT</a>     | Active        | Production           | SC70 (DCK)   5    | 250   SMALL T&R       | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 85    | (HN5, HNR)           |
| <a href="#">SN74AUP1G126DCKT.B</a>   | Active        | Production           | SC70 (DCK)   5    | 250   SMALL T&R       | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 85    | (HN5, HNR)           |
| <a href="#">SN74AUP1G126DPWR</a>     | Active        | Production           | X2SON (DPW)   5   | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | C4                   |
| <a href="#">SN74AUP1G126DPWR.B</a>   | Active        | Production           | X2SON (DPW)   5   | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | C4                   |
| <a href="#">SN74AUP1G126DRLR</a>     | Active        | Production           | SOT-5X3 (DRL)   5 | 4000   LARGE T&R      | Yes         | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM                | -40 to 85    | (HN7, HNR)           |
| <a href="#">SN74AUP1G126DRLR.B</a>   | Active        | Production           | SOT-5X3 (DRL)   5 | 4000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | (HN7, HNR)           |
| <a href="#">SN74AUP1G126DRYR</a>     | Active        | Production           | SON (DRY)   6     | 5000   LARGE T&R      | Yes         | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM                | -40 to 85    | HN                   |
| <a href="#">SN74AUP1G126DRYR.B</a>   | Active        | Production           | SON (DRY)   6     | 5000   LARGE T&R      | Yes         | NIPDAUAG                             | Level-1-260C-UNLIM                | -40 to 85    | HN                   |
| <a href="#">SN74AUP1G126DSFR</a>     | Active        | Production           | SON (DSF)   6     | 5000   LARGE T&R      | Yes         | NIPDAU   NIPDAUAG                    | Level-1-260C-UNLIM                | -40 to 85    | HN                   |
| <a href="#">SN74AUP1G126DSFR.B</a>   | Active        | Production           | SON (DSF)   6     | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HN                   |
| <a href="#">SN74AUP1G126DSFRG4</a>   | Active        | Production           | SON (DSF)   6     | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HN                   |
| <a href="#">SN74AUP1G126DSFRG4.B</a> | Active        | Production           | SON (DSF)   6     | 5000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HN                   |
| <a href="#">SN74AUP1G126YFPR</a>     | Active        | Production           | DSBGA (YFP)   6   | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -            | HNN                  |
| <a href="#">SN74AUP1G126YFPR.B</a>   | Active        | Production           | DSBGA (YFP)   6   | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | HNN                  |
| <a href="#">SN74AUP1G126YZPR</a>     | Active        | Production           | DSBGA (YZP)   5   | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | HNN                  |
| <a href="#">SN74AUP1G126YZPR.B</a>   | Active        | Production           | DSBGA (YZP)   5   | 3000   LARGE T&R      | Yes         | SNAGCU                               | Level-1-260C-UNLIM                | -40 to 85    | HNN                  |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

**(2) Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

**(3) RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

**(4) Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

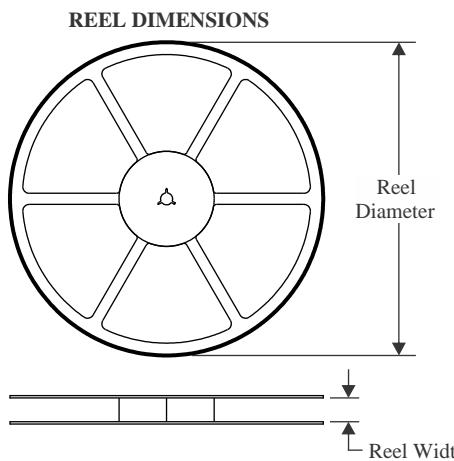
**(5) MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74AUP1G126DBVR   | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AUP1G126DBVRG4 | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AUP1G126DBVT   | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| SN74AUP1G126DCKR   | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74AUP1G126DCKT   | SC70         | DCK             | 5    | 250  | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| SN74AUP1G126DPWR   | X2SON        | DPW             | 5    | 3000 | 178.0              | 8.4                | 0.91    | 0.91    | 0.5     | 2.0     | 8.0    | Q3            |
| SN74AUP1G126DRLR   | SOT-5X3      | DRL             | 5    | 4000 | 180.0              | 8.4                | 1.98    | 1.78    | 0.69    | 4.0     | 8.0    | Q3            |
| SN74AUP1G126DRYR   | SON          | DRY             | 6    | 5000 | 180.0              | 9.5                | 1.15    | 1.6     | 0.75    | 4.0     | 8.0    | Q1            |
| SN74AUP1G126DSFR   | SON          | DSF             | 6    | 5000 | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| SN74AUP1G126DSFRG4 | SON          | DSF             | 6    | 5000 | 180.0              | 9.5                | 1.16    | 1.16    | 0.5     | 4.0     | 8.0    | Q2            |
| SN74AUP1G126YFPR   | DSBGA        | YFP             | 6    | 3000 | 178.0              | 9.2                | 0.89    | 1.29    | 0.62    | 4.0     | 8.0    | Q1            |
| SN74AUP1G126YZPR   | DSBGA        | YZP             | 5    | 3000 | 178.0              | 9.2                | 1.02    | 1.52    | 0.63    | 4.0     | 8.0    | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AUP1G126DBVR   | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DBVRG4 | SOT-23       | DBV             | 5    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DBVT   | SOT-23       | DBV             | 5    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DCKR   | SC70         | DCK             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| SN74AUP1G126DCKT   | SC70         | DCK             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| SN74AUP1G126DPWR   | X2SON        | DPW             | 5    | 3000 | 205.0       | 200.0      | 33.0        |
| SN74AUP1G126DRLR   | SOT-5X3      | DRL             | 5    | 4000 | 202.0       | 201.0      | 28.0        |
| SN74AUP1G126DRYR   | SON          | DRY             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G126DSFR   | SON          | DSF             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G126DSFRG4 | SON          | DSF             | 6    | 5000 | 184.0       | 184.0      | 19.0        |
| SN74AUP1G126YFPR   | DSBGA        | YFP             | 6    | 3000 | 220.0       | 220.0      | 35.0        |
| SN74AUP1G126YZPR   | DSBGA        | YZP             | 5    | 3000 | 220.0       | 220.0      | 35.0        |

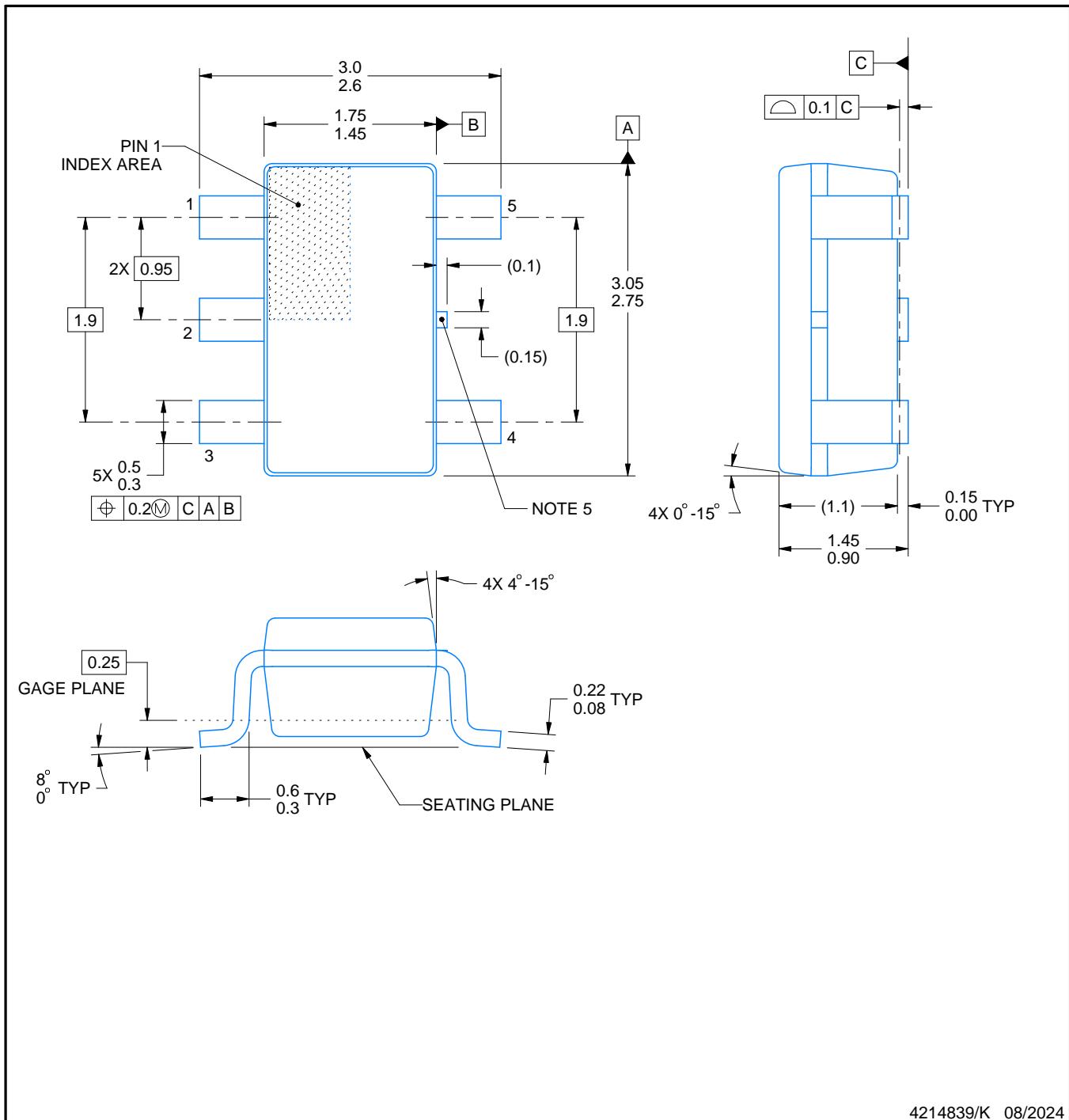
## PACKAGE OUTLINE

DBV0005A



## **SOT-23 - 1.45 mm max height**

## SMALL OUTLINE TRANSISTOR



4214839/K 08/2024

## NOTES:

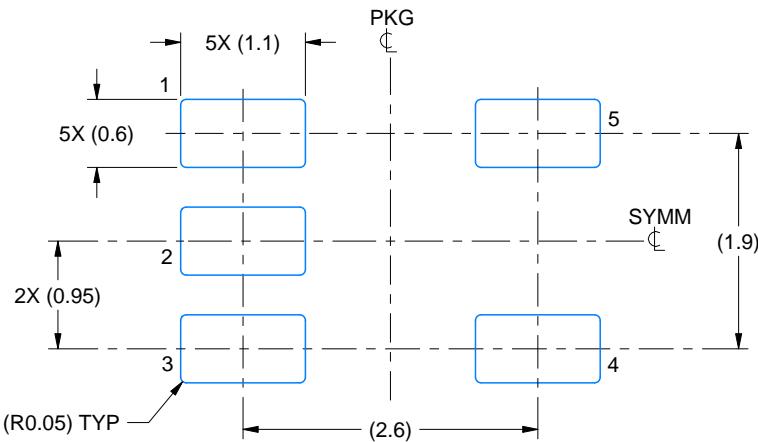
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

# EXAMPLE BOARD LAYOUT

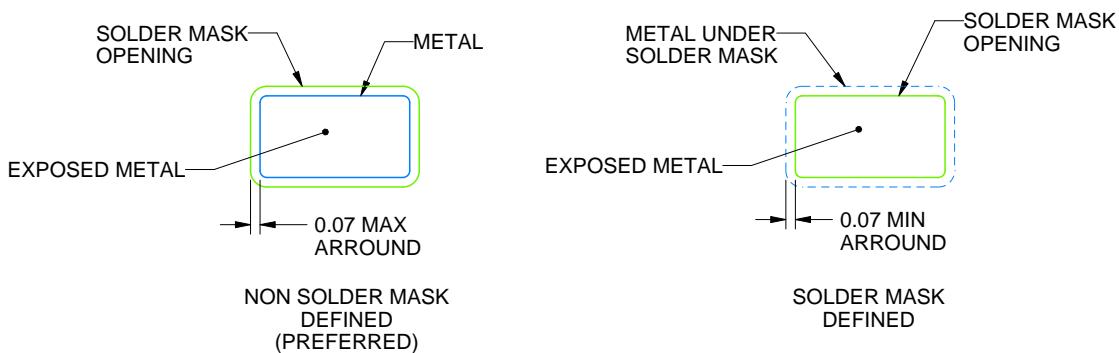
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

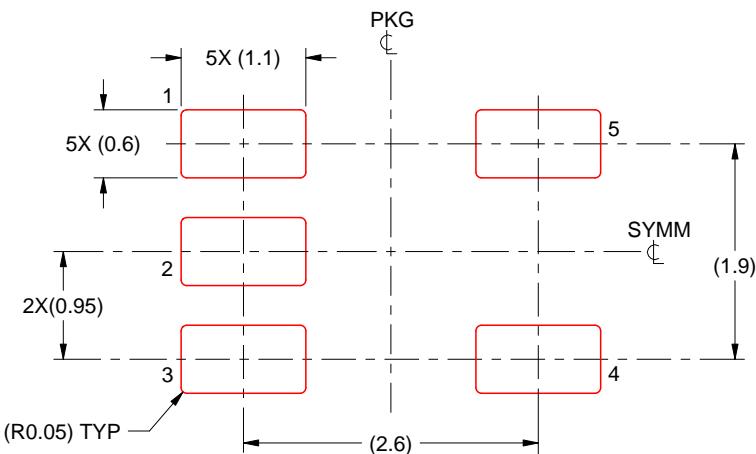
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

**DRY 6**

**GENERIC PACKAGE VIEW**

**USON - 0.6 mm max height**

PLASTIC SMALL OUTLINE - NO LEAD

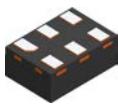


Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4207181/G

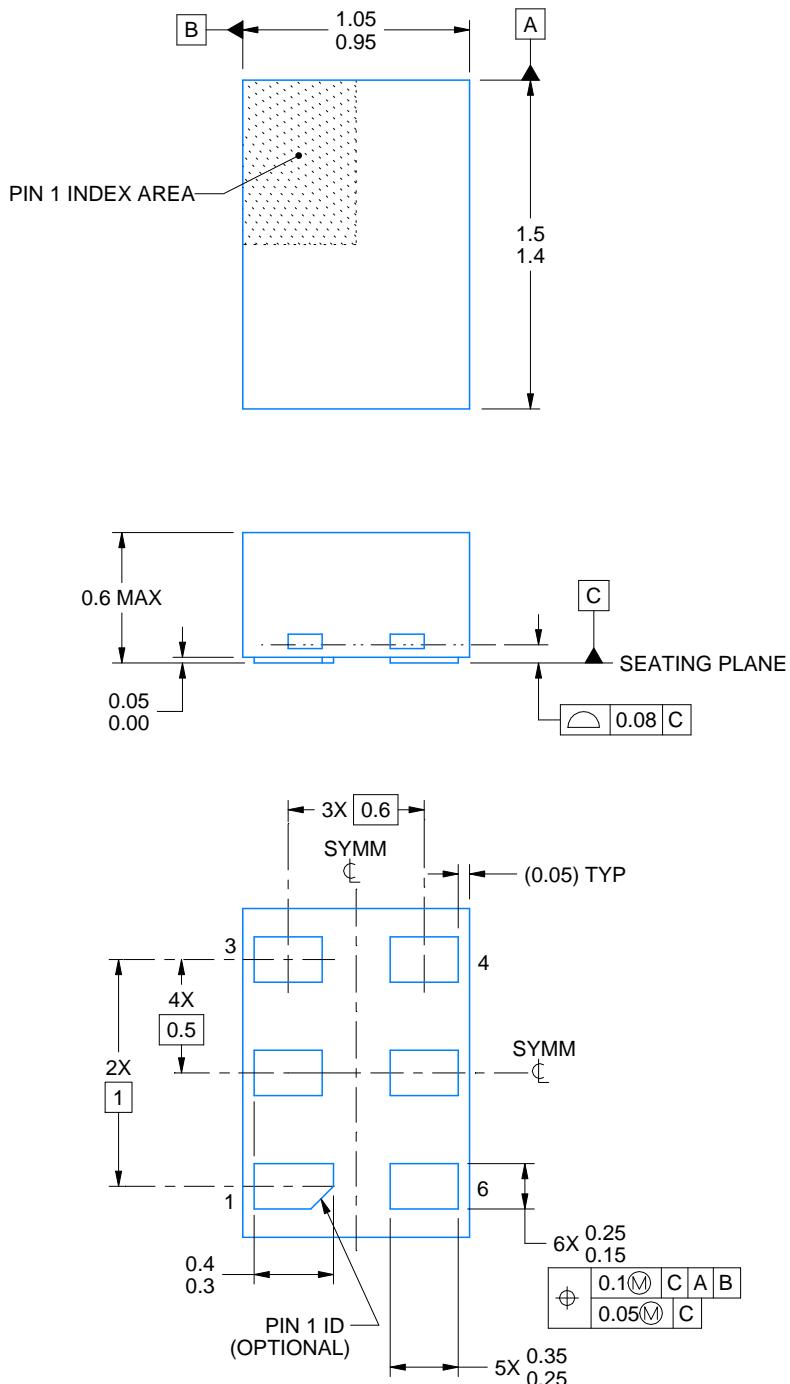
## PACKAGE OUTLINE

**DRY0006A**



## USON - 0.6 mm max height

## PLASTIC SMALL OUTLINE - NO LEAD



4222894/A 01/2018

## NOTES:

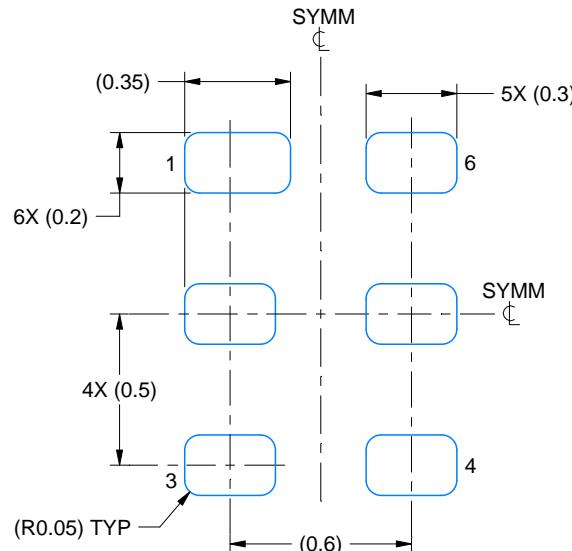
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

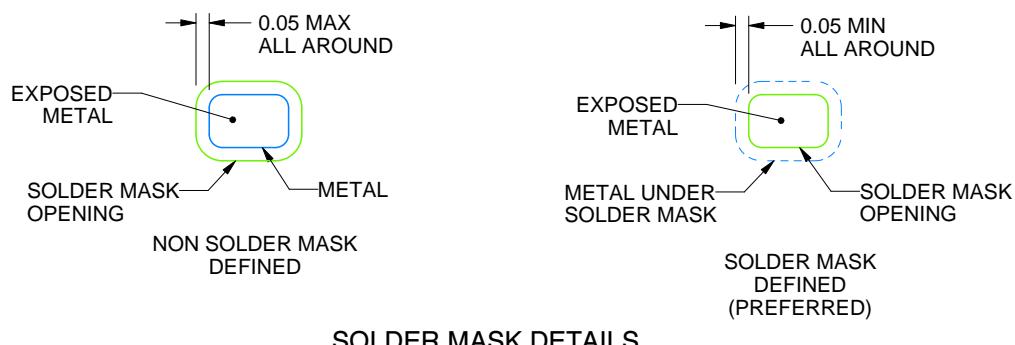
DRY0006A

USON - 0.6 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE  
1:1 RATIO WITH PKG SOLDER PADS  
EXPOSED METAL SHOWN  
SCALE:40X



SOLDER MASK DETAILS

4222894/A 01/2018

NOTES: (continued)

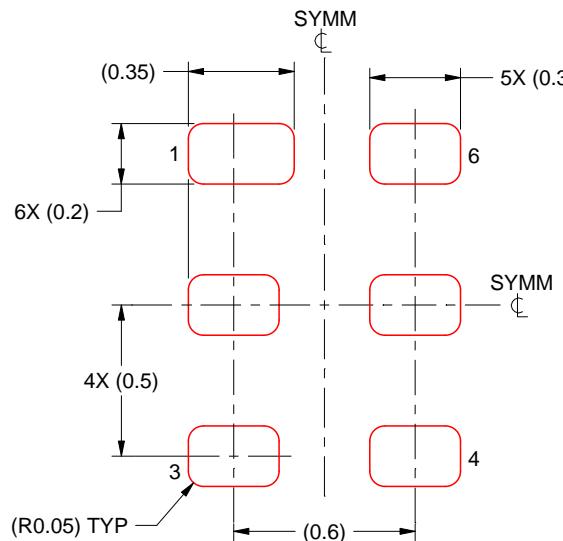
3. For more information, see QFN/SON PCB application report in literature No. SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

# EXAMPLE STENCIL DESIGN

DRY0006A

USON - 0.6 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.075 - 0.1 mm THICK STENCIL  
SCALE:40X

4222894/A 01/2018

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

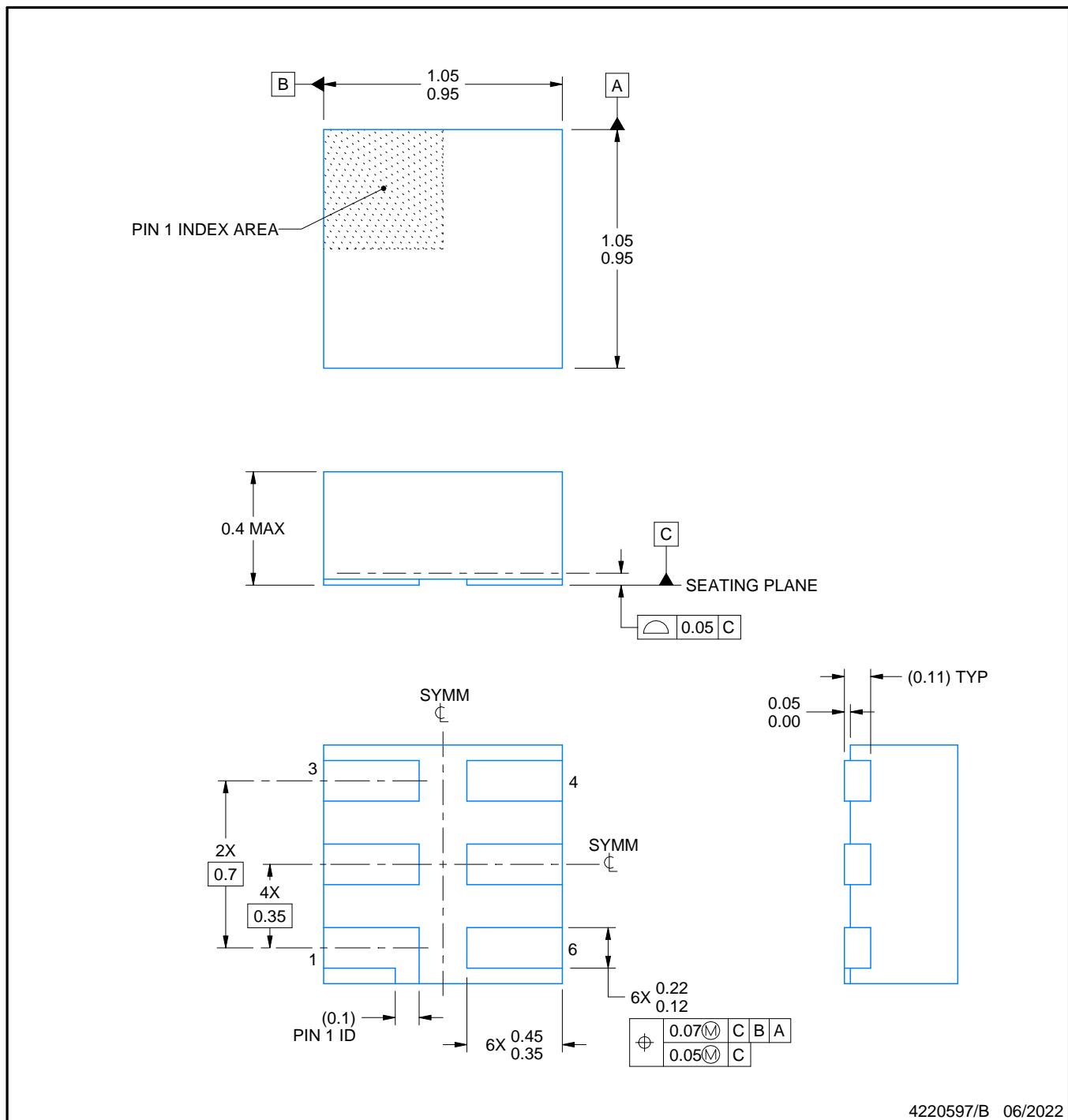


## PACKAGE OUTLINE

**DSF0006A**

## X2SON - 0.4 mm max height

## PLASTIC SMALL OUTLINE - NO LEAD



## NOTES:

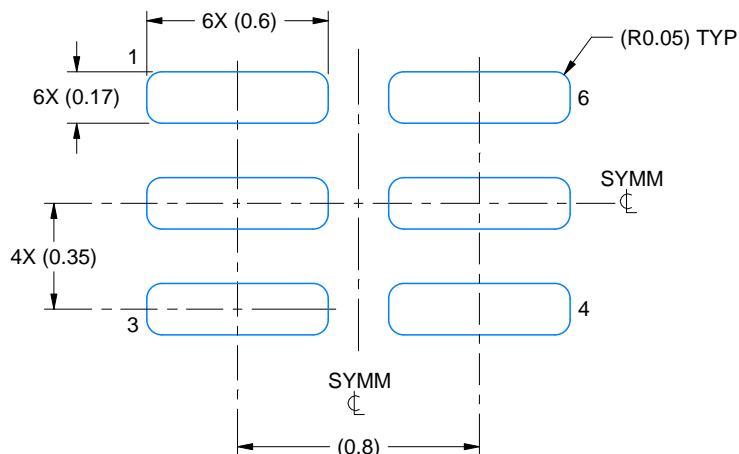
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration MO-287, variation X2AAF.

# EXAMPLE BOARD LAYOUT

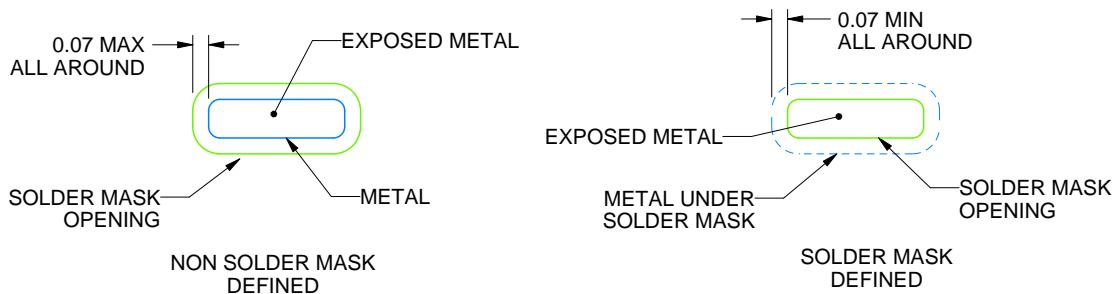
DSF0006A

X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:40X



SOLDER MASK DETAILS

4220597/B 06/2022

NOTES: (continued)

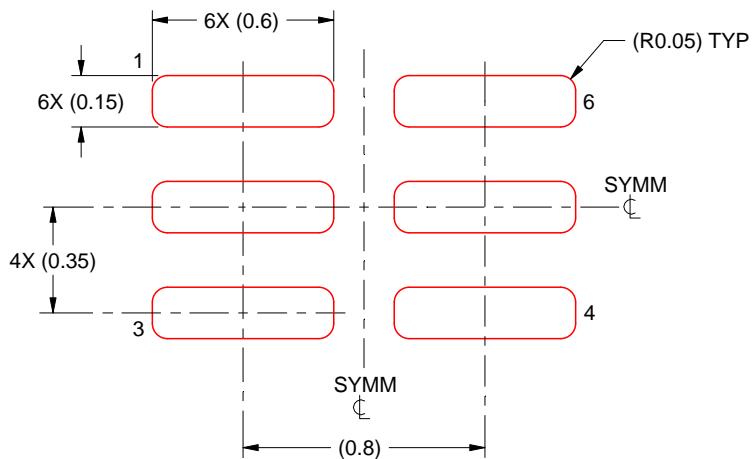
4. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

# EXAMPLE STENCIL DESIGN

DSF0006A

X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.09 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:40X

4220597/B 06/2022

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

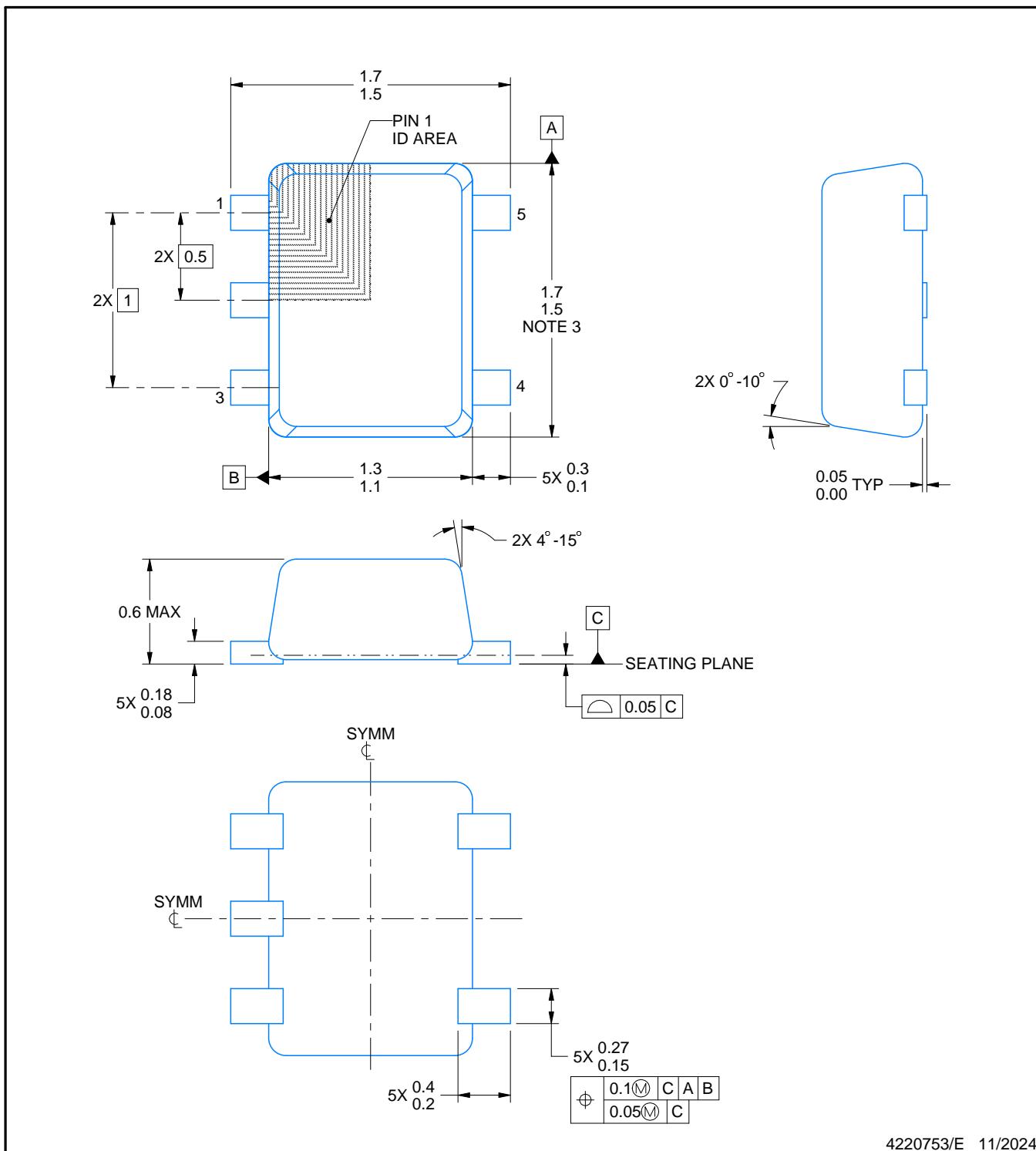
# PACKAGE OUTLINE

DRL0005A



SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



4220753/E 11/2024

## NOTES:

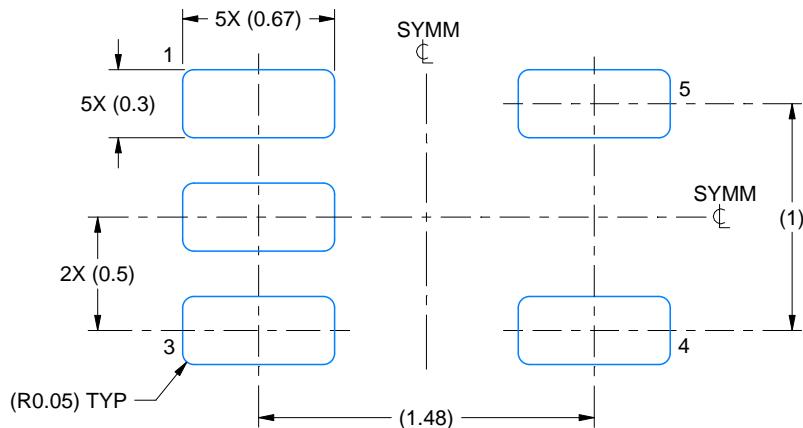
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-293 Variation UAAD-1

# EXAMPLE BOARD LAYOUT

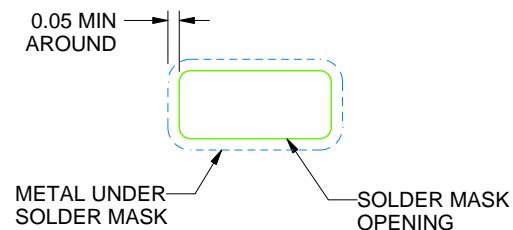
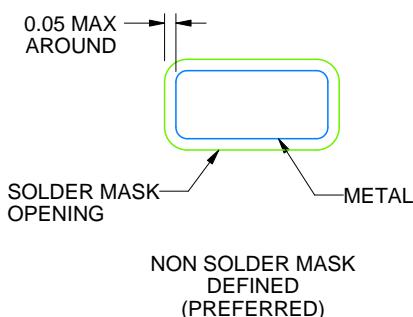
DRL0005A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



LAND PATTERN EXAMPLE  
SCALE:30X



SOLDERMASK DETAILS

4220753/E 11/2024

NOTES: (continued)

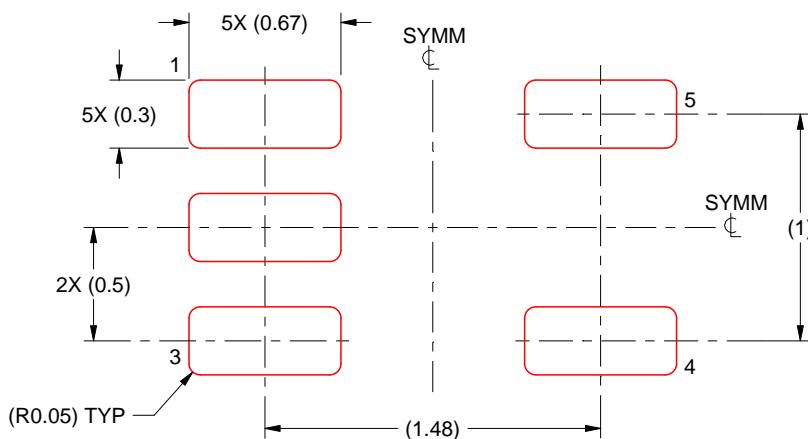
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DRL0005A

SOT - 0.6 mm max height

PLASTIC SMALL OUTLINE



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:30X

4220753/E 11/2024

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

DPW 5

X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4211218-3/D

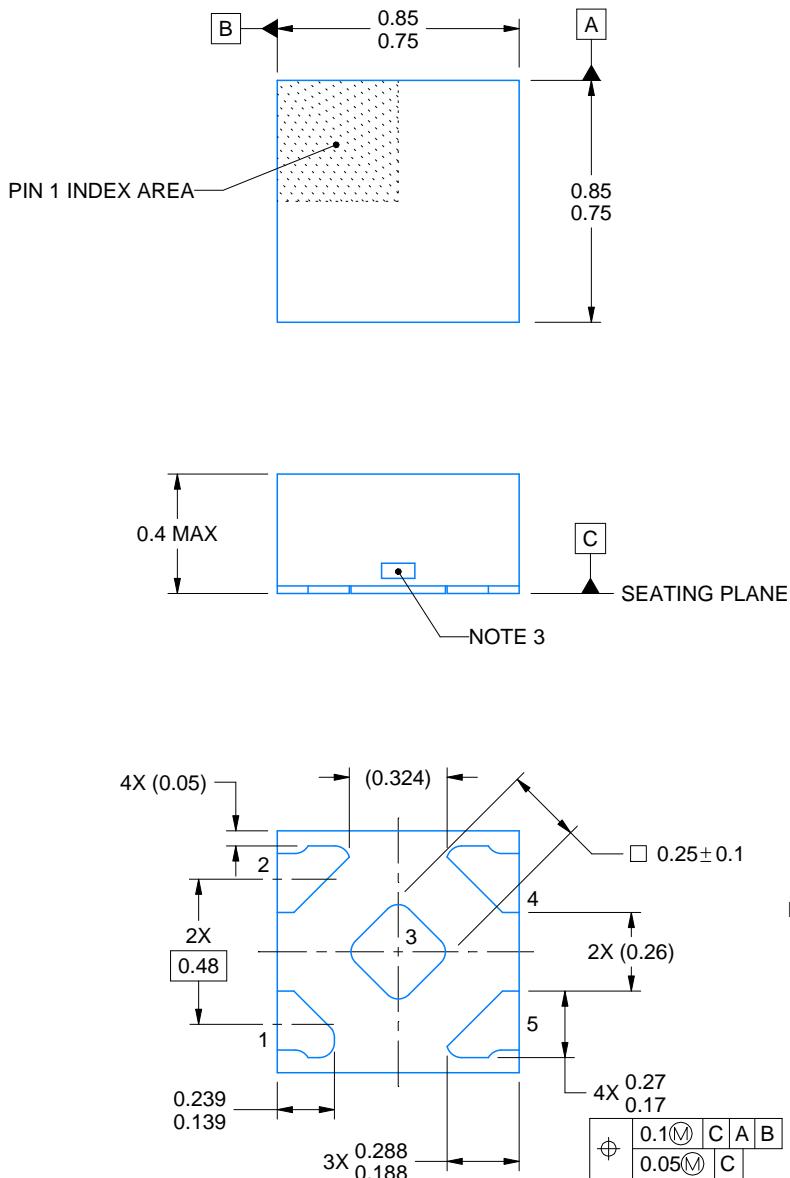
# PACKAGE OUTLINE

DPW0005A



X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



4223102/D 03/2022

NOTES:

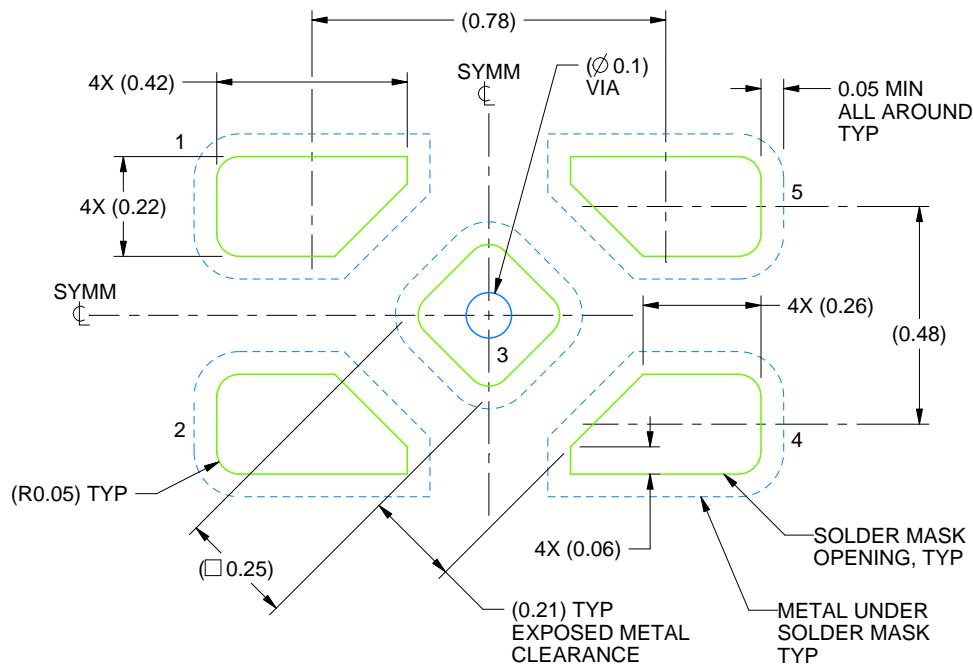
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The size and shape of this feature may vary.

# EXAMPLE BOARD LAYOUT

DPW0005A

X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE  
SOLDER MASK DEFINED  
SCALE:60X

4223102/D 03/2022

NOTES: (continued)

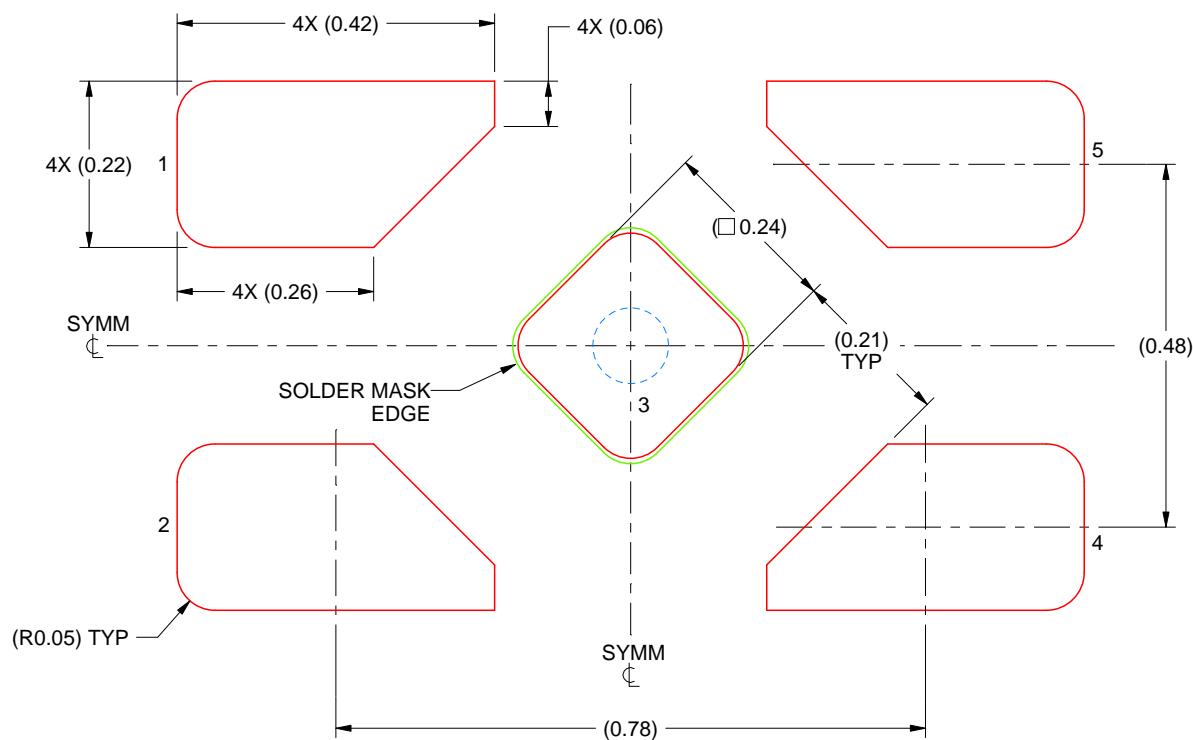
4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

# EXAMPLE STENCIL DESIGN

DPW0005A

X2SON - 0.4 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL

EXPOSED PAD 3  
92% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:100X

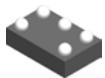
4223102/D 03/2022

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

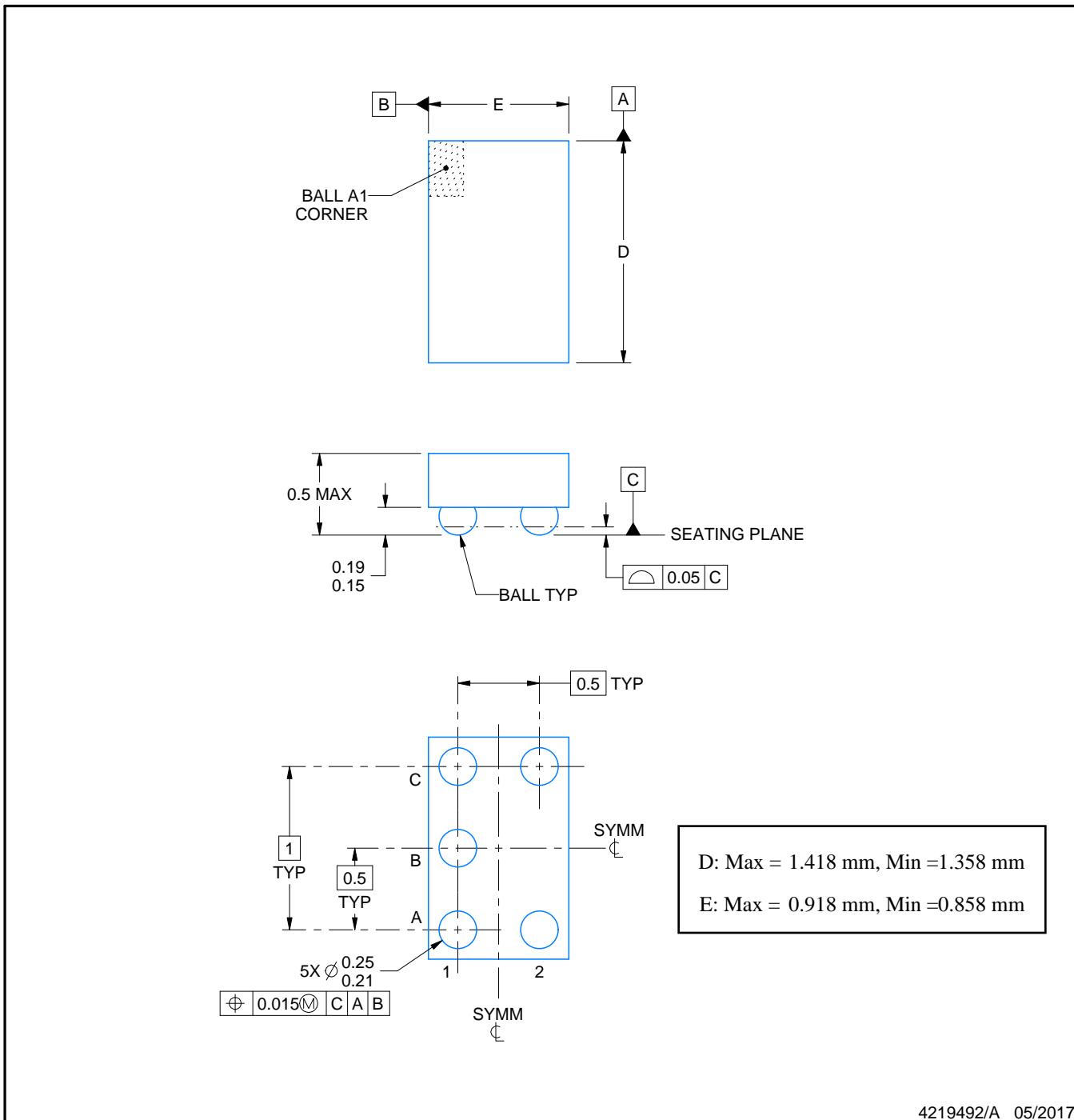
# PACKAGE OUTLINE

YZP0005



DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



4219492/A 05/2017

## NOTES:

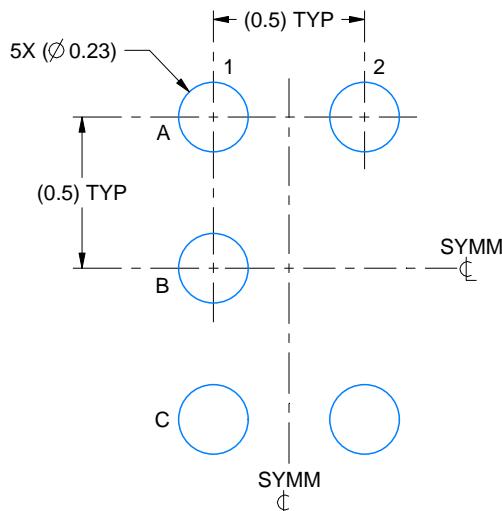
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

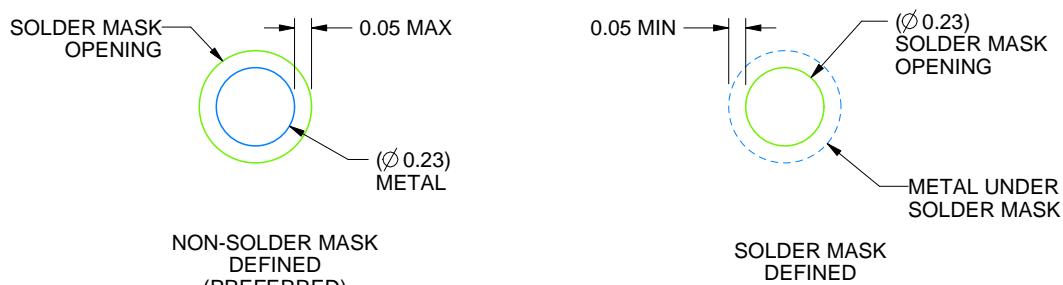
YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:40X



SOLDER MASK DETAILS  
NOT TO SCALE

4219492/A 05/2017

NOTES: (continued)

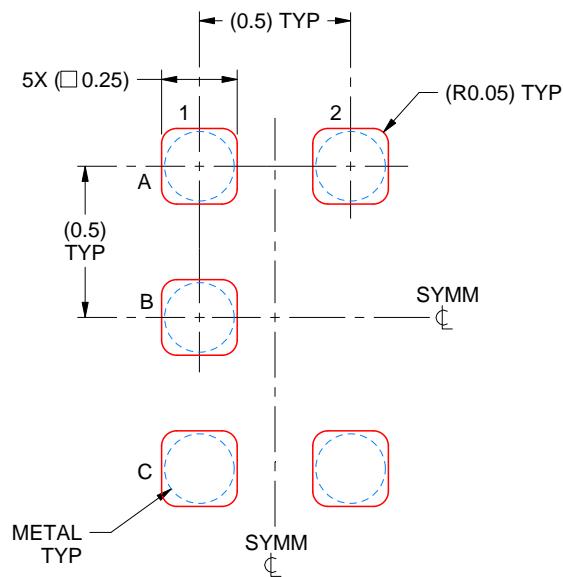
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

# EXAMPLE STENCIL DESIGN

YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:40X

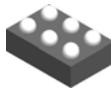
4219492/A 05/2017

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

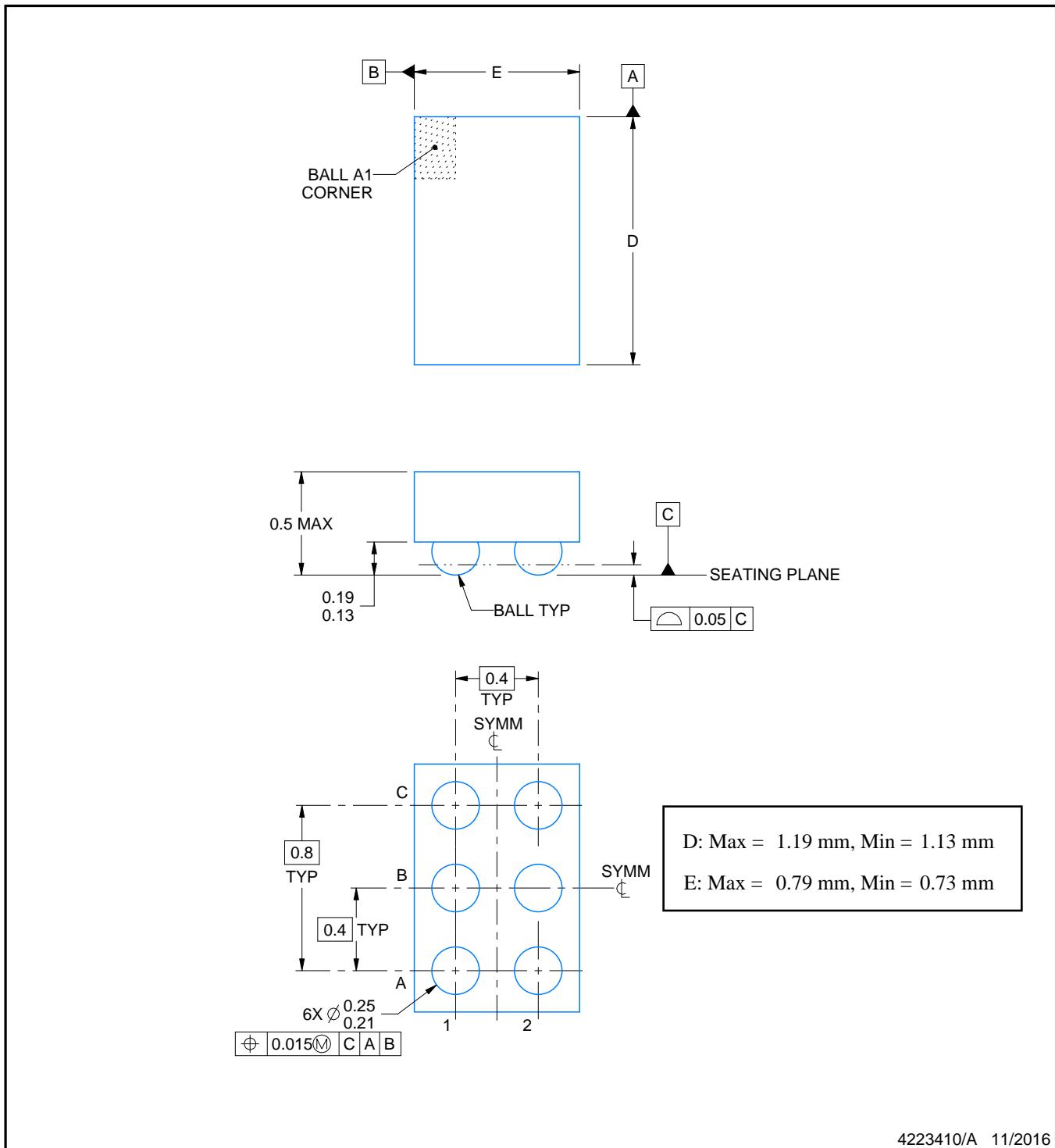
# PACKAGE OUTLINE

**YFP0006**



**DSBGA - 0.5 mm max height**

DIE SIZE BALL GRID ARRAY



4223410/A 11/2016

**NOTES:**

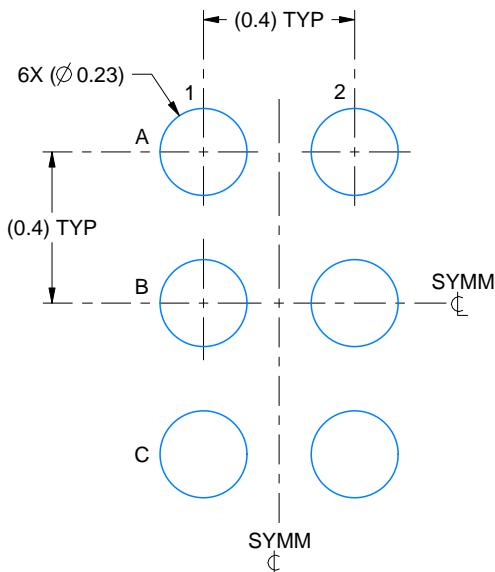
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

# EXAMPLE BOARD LAYOUT

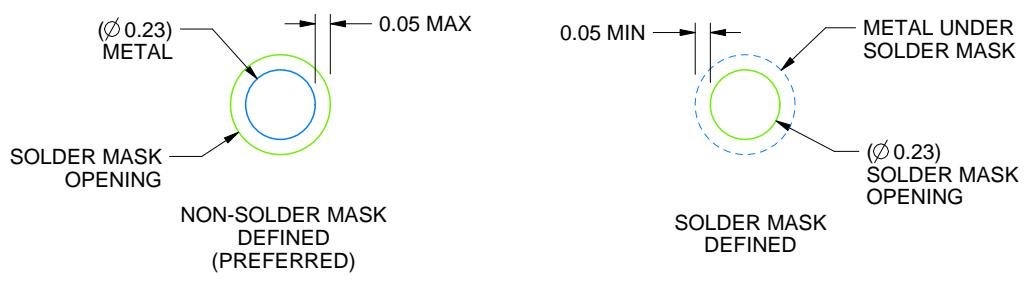
YFP0006

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE  
SCALE:50X



SOLDER MASK DETAILS  
NOT TO SCALE

4223410/A 11/2016

NOTES: (continued)

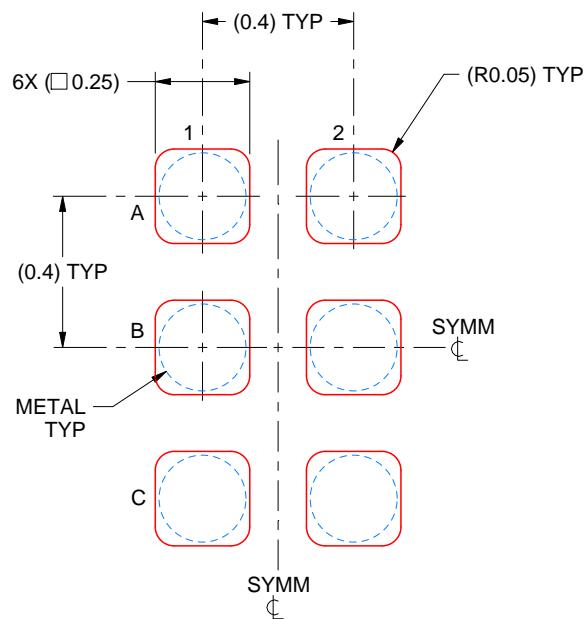
3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints.  
For more information, see Texas Instruments literature number SNVA009 ([www.ti.com/lit/snva009](http://www.ti.com/lit/snva009)).

# EXAMPLE STENCIL DESIGN

YFP0006

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



SOLDER PASTE EXAMPLE  
BASED ON 0.1 mm THICK STENCIL  
SCALE:50X

4223410/A 11/2016

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.

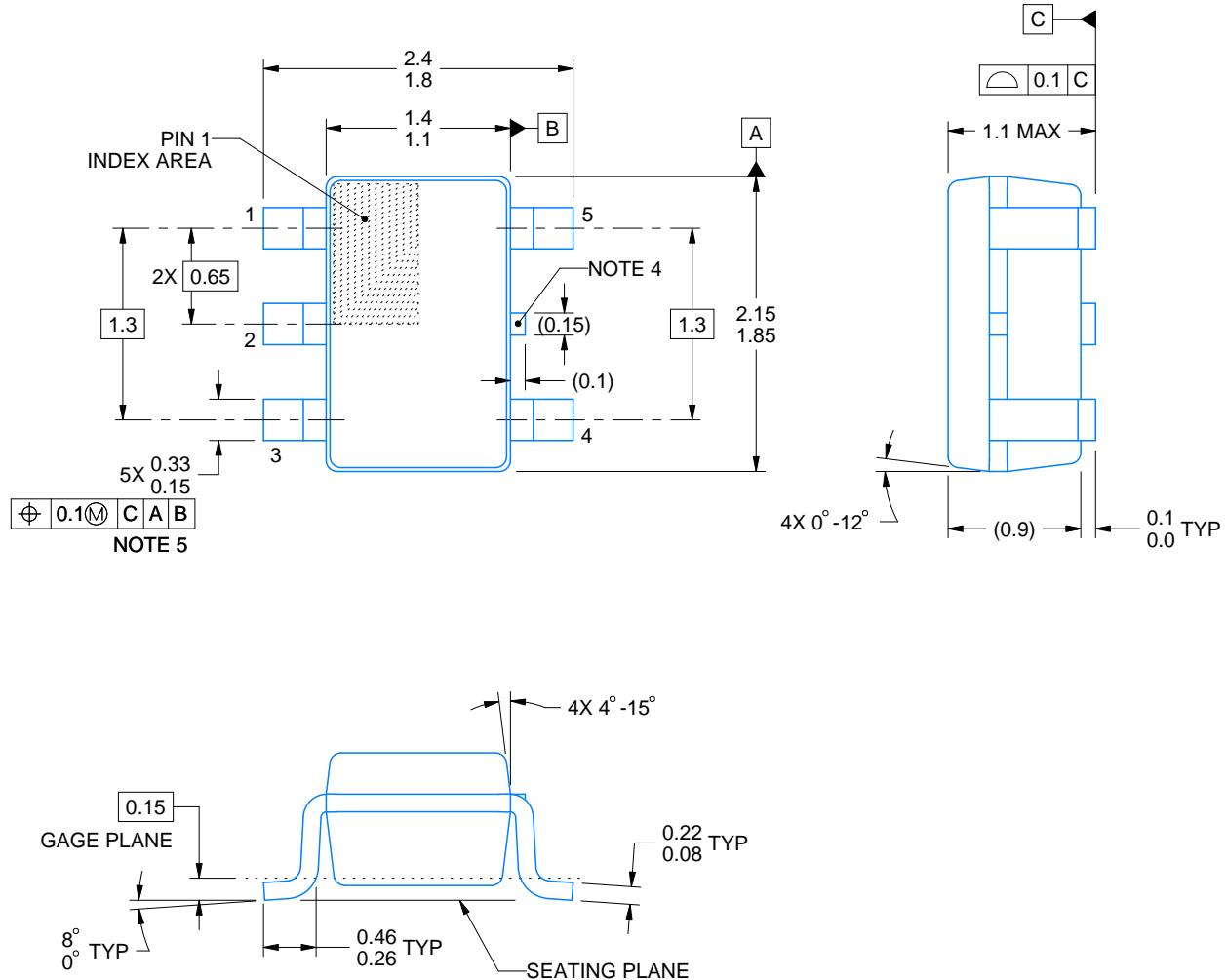
## PACKAGE OUTLINE

**DCK0005A**



## SOT - 1.1 max height

## SMALL OUTLINE TRANSISTOR



4214834/G 11/2024

## NOTES:

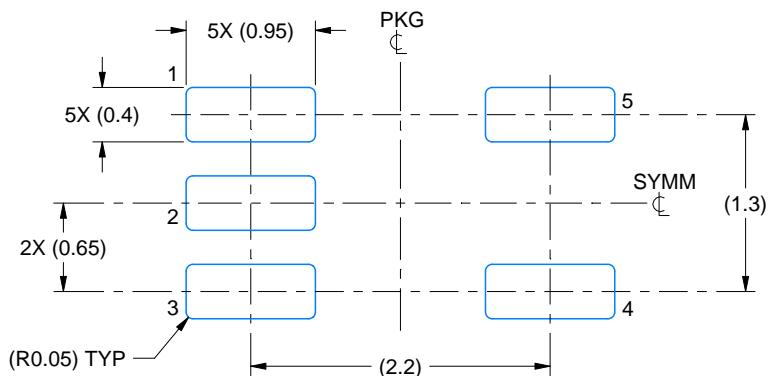
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

## EXAMPLE BOARD LAYOUT

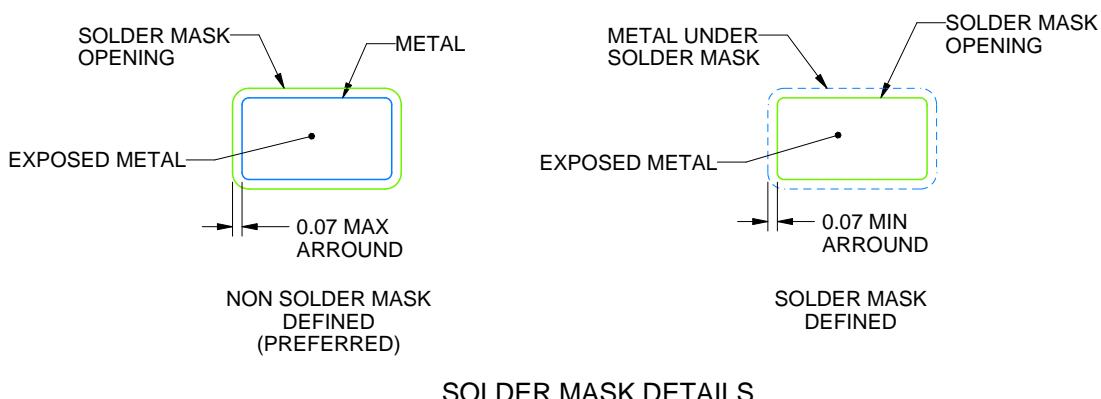
**DCK0005A**

## SOT - 1.1 max height

## SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X



4214834/G 11/2024

#### NOTES: (continued)

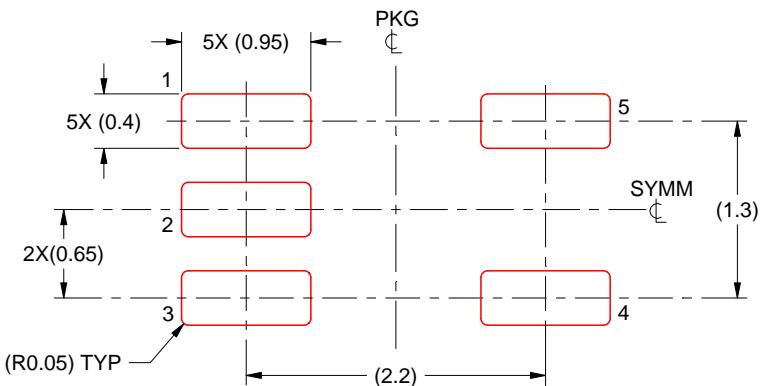
7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE:18X

4214834/G 11/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

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